

68HC05LJ5

SPECIFICATION (General Release)

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Semiconductor Products Sector

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SECTION 1 GENERAL DESCRIPTION

The MC68HC05LJ5 HCMOS Microcontroller is a member of the MC68HC05 Family of low-cost single-chip 8-bit Microcontroller Units (MCUs). The MC68HC05LJ5 is an enhanced version of the MC68HC05J5, which includes high sink current port pins, slow output transition port pins, an extra interrupt on a port pin, low-voltage-reset, and a tight tolerance RC oscillator option.

The MC68HC05LJ5 is available in 16-pin and 20-pin packages.

The 16-pin version has four less I/O port lines than the 20-pin version.

Although the MC68HC05LJ5 is an enhanced version of the MC68HC05J5, pin assignments are different.

1.1 FEATURES

- Industry standard M68HC05 CPU core
- Fully static operation with no minimum clock speed
- 1296 bytes of user ROM including 16 bytes User Vector
- 64 bytes of user RAM
- 14 bidirectional I/O pins (10 bidirectional I/O pins for 16-pin package)
- On-chip Oscillator:
 - Crystal/Resonator Oscillator or
 - RC Oscillator with only one external resistor required
- Hardware mask and flag for external interrupts
- 15-bit Multi-Function Timer
- Power saving STOP and WAIT modes
- Computer Operating Properly (COP) watchdog
- Low Voltage Reset (LVR)
- Illegal Address Reset (ILADR)
- Available in 16-pin PDIP, 20-pin PDIP, and 20-pin SOIC packages

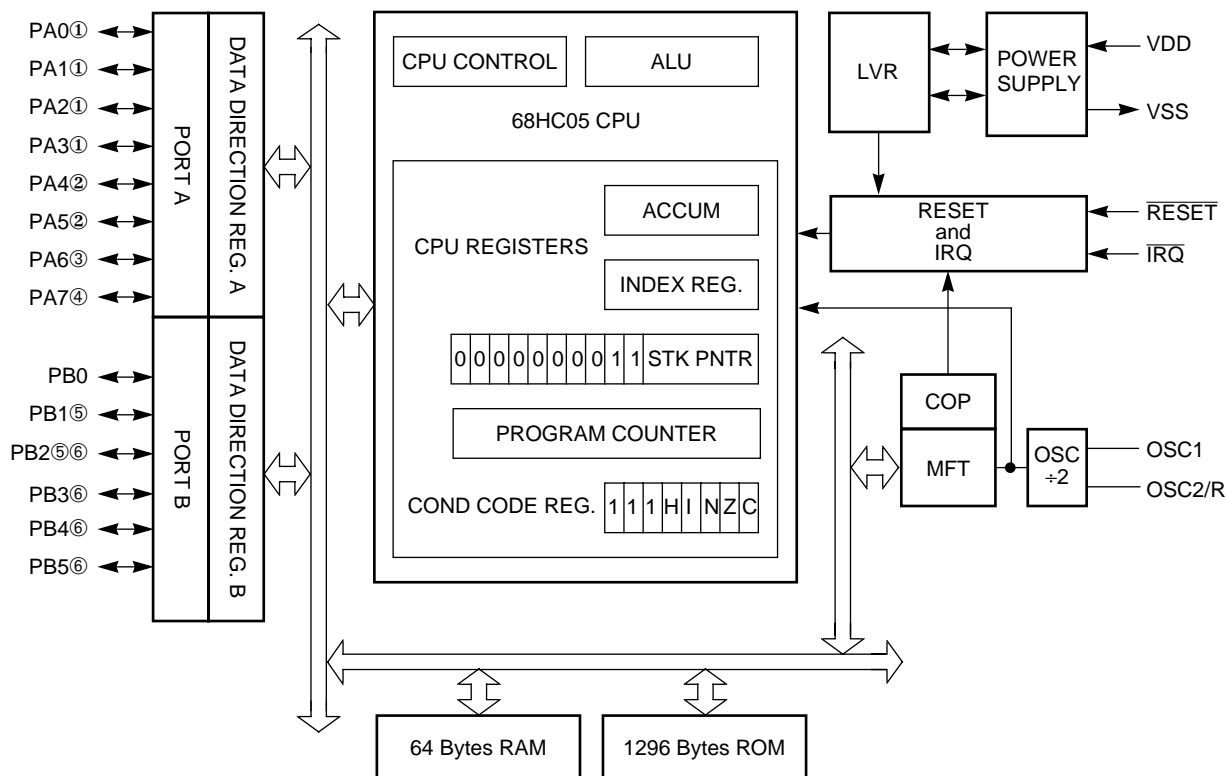
1.2 MASK OPTIONS

The following mask options are available:

Table 1-1. MC68HC05LJ5 Mask Options

MASK	OPTION
On-chip oscillator	[Crystal/Resonator] or [RC]
Crystal/resonator feedback resistor	[Connected] or [Disconnected]
STOP instruction convert to WAIT	[Enabled] or [Disabled]
PA0-PA3 external interrupt capability	[Enabled] or [Disabled]
External interrupt pins (IRQ, PA0-PA3)	[Edge-triggered] or [Edge and level triggered]
Port A and Port B pull-down/pull-up resistors	[Connected] or [Disconnected]
COP Watchdog Timer	[Enabled] or [Disabled]
Low Voltage Reset	[Enabled] or [Disabled]

1.3 MCU STRUCTURE



- ①: External edge interrupt capability
- ②: 8mA current sink
- ③: 8mA current sink, open-drained with internal pull-up
- ④: 8mA current sink, open-drained with internal pull-up, external interrupt capability
- ⑤: 25mA current sink, open-drained with internal pull-up
- ⑥: Pins not available on 16-pin package

Figure 1-1. MC68HC05LJ5 Block Diagram

1.4 PIN ASSIGNMENTS

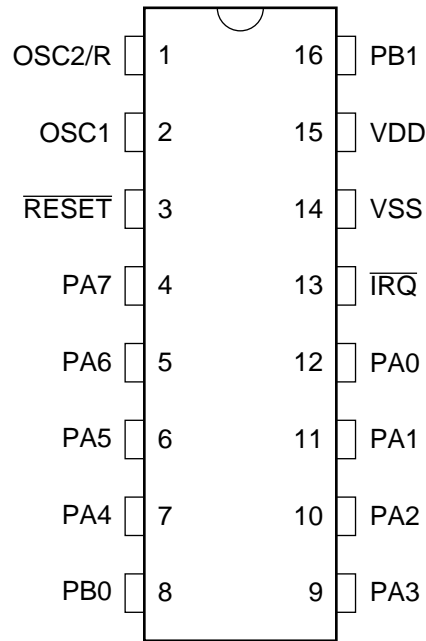


Figure 1-2. Pin Assignment for 16-Pin Package

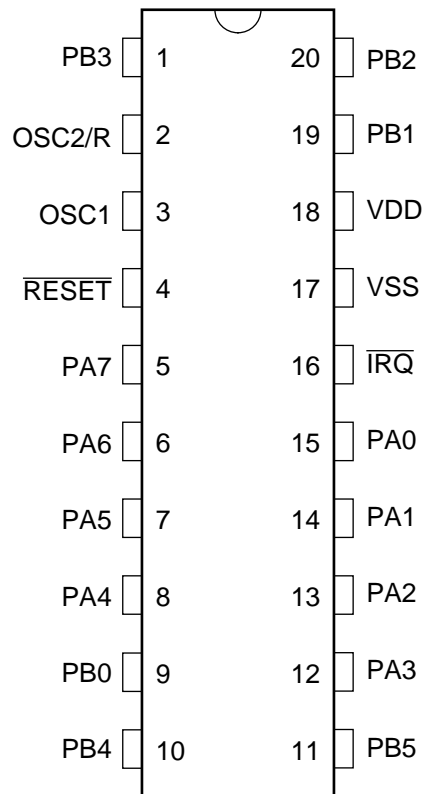


Figure 1-3. Pin Assignment for 20-Pin Package

1.5 FUNCTIONAL PIN DESCRIPTION

The following paragraphs give a description of the general function of each pin assigned in **Figure 1-2** and **Figure 1-3**.

1.5.1 V_{DD} AND V_{SS}

Power is supplied to the MCU through V_{DD} and V_{SS} . V_{DD} is the positive supply, and V_{SS} is ground. The MCU operates from a single power supply.

Very fast signal transitions occur on the MCU pins. The short rise and fall times place very high short-duration current demands on the power supply. To prevent noise problems, special care should be taken to provide good power supply bypassing at the MCU by using bypass capacitors with good high-frequency characteristics that are positioned as close to the MCU as possible. Bypassing requirements vary, depending on how heavily the MCU pins are loaded.

1.5.2 OSC1, OSC2/R

The OSC1 and OSC2/R pins are the connections for the on-chip oscillator. The OSC1 and OSC2/R pins can accept the following sets of components:

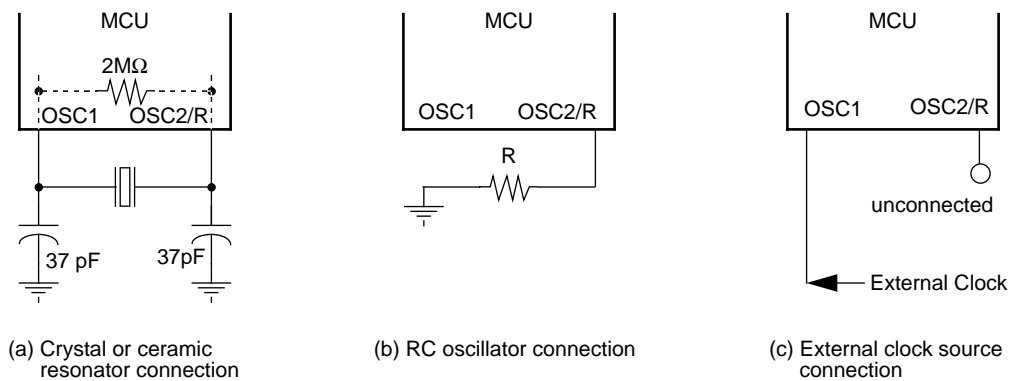
1. A crystal as shown in **Figure 1-4(a)**
2. A ceramic resonator as shown in **Figure 1-4(a)**
3. An external resistor as shown in **Figure 1-4(b)**
4. An external clock signal as shown in **Figure 1-4(c)**

The frequency, f_{OSC} , of the oscillator or external clock source is divided by two to produce the internal operating frequency, f_{OP} . The type of oscillator is selected by a mask option. An internal $2M\Omega$ resistor may be selected between OSC1 and OSC2/R by a mask option (crystal/ceramic resonator mode only).

If the RC oscillator option is selected, OSC1 pin should be connected to a known logic level, either one or zero.

Crystal Oscillator

The circuit in **Figure 1-4(a)** shows a typical oscillator circuit for an AT-cut, parallel resonant crystal. The crystal manufacturer's recommendations should be followed, as the crystal parameters determine the external component values required to provide maximum stability and reliable start-up. The load capacitance values used in the oscillator circuit design should include all stray capacitances. The crystal and components should be mounted as close as possible to the pins for start-up stabilization and to minimize output distortion. An internal start-up resistor of approximately $2 M\Omega$ is provided between OSC1 and OSC2/R for the crystal type oscillator as a mask option.


Figure 1-4. Oscillator Connections

Ceramic Resonator Oscillator

In cost-sensitive applications, a ceramic resonator can be used in place of the crystal. The circuit in **Figure 1-4(a)** can be used for a ceramic resonator. The resonator manufacturer's recommendations should be followed, as the resonator parameters determine the external component values required for maximum stability and reliable starting. The load capacitance values used in the oscillator circuit design should include all stray capacitances. The ceramic resonator and components should be mounted as close as possible to the pins for start-up stabilization and to minimize output distortion. An internal start-up resistor of approximately 2 M Ω is provided between OSC1 and OSC2/R for the ceramic resonator type oscillator as a mask option.

RC Oscillator

The lowest cost oscillator is the RC oscillator configuration. With this option an external resistor is connected between OSC2/R pin and the V_{SS} pin as shown in **Figure 1-4(b)**. The typical operating frequency f_{OSC} is set at 4 MHz with the external R tied to V_{SS}. The internal start-up resistor of approximately 2 M Ω is not connected between OSC1 and OSC2/R for the mask option of the RC type oscillator.

The tolerance of this RC oscillator is guaranteed to be no greater than $\pm 15\%$ at the specified conditions of 0 °C to 40 °C and 5V $\pm 10\%$ V_{DD} providing that the tolerance of the external resistor R is at most $\pm 1\%$ and the center frequency range is from 3.8MHz to 4.2MHz. The center frequency is the nominal operating frequency of the RC oscillator and can be adjusted by adjusting the external R value to change the internal VCO charging current.

In order to obtain an oscillator clock with the best possible tolerance, the external resistor connected to the OSC2/R pin should be grounded as close to the VSS pin as possible and the other terminal of this external resistor should be connected as close to the OSC2/R pin as possible.

External Clock

An external clock from another CMOS-compatible device can be connected to the OSC1 input, with the OSC2/R input not connected, as shown in **Figure 1-4(c)**. This configuration is possible only when the crystal/ceramic resonator mask option is selected.

1.5.3 RESET

This is an I/O pin. This pin can be used as an input to reset the MCU to a known start-up state by pulling it to the low state. The $\overline{\text{RESET}}$ pin contains a steering diode to discharge any voltage on the pin to V_{DD} , when the power is removed. An internal pull-up is also connected between this pin and V_{DD} . The $\overline{\text{RESET}}$ pin contains an internal Schmitt trigger to improve its noise immunity as an input. This pin is an output pin if LVR triggers an internal reset.

1.5.4 $\overline{\text{IRQ}}$

This input pin drives the asynchronous $\overline{\text{IRQ}}$ interrupt function of the CPU. The $\overline{\text{IRQ}}$ interrupt function has a mask option to provide either only negative edge-sensitive triggering or both negative edge-sensitive and low level-sensitive triggering. If the option is selected to include level-sensitive triggering, the $\overline{\text{IRQ}}$ input requires an external resistor to V_{DD} for "wired-OR" operation, if desired. The $\overline{\text{IRQ}}$ pin contains an internal Schmitt trigger as part of its input to improve noise immunity.

NOTE

Each of the PA0 to PA3 I/O pins may be connected as an OR function with the IRQ interrupt function by a mask option. This capability allows keyboard scan applications where the transitions or levels on the I/O pins will behave the same as the $\overline{\text{IRQ}}$ pin, except for the inverted phase. The edge or level sensitivity selected by a separate mask option for the $\overline{\text{IRQ}}$ pin also applies to the I/O pins OR'ed to create the IRQ signal. Besides, PA7 also has falling-edge only interrupt capability whose functionality is controlled by another set of register bits.

1.5.5 PA0-PA7

These eight I/O lines comprise Port A. PA6 and PA7 are open-drained pins with pull-up devices whereas PA0 to PA5 are push-pull pins with pull-down devices. PA4 to PA7 are also capable of sinking 8 mA.

The state of any pin is software programmable and all Port A lines are configured as inputs during power-on or reset. The lower four I/O pins (PA0 to PA3) can be connected via an internal OR gate to the IRQ interrupt function enabled by a mask option. Another independent interrupt source comes from the falling edge on PA7. PA7 interrupt source is associated with a second set of interrupt control/status bits. All Port A pins except PA6 and PA7 have software programmable pull-down devices also provided by a mask option. PA6 and PA7 pins have software programmable pull-up devices also provided by the same mask option. Pull-up

devices on PA6 and PA7 once enabled are always enabled regardless of pin direction configuration, unlike pull-down devices on PA0 to PA5 which are activated only when these pins are configured as input pins.

PA6 and PA7 pins, when configured as output pins, also have slow output falling-edge transition feature to reduce EMI. The falling-edge transition time is tentatively set at 250ns typical at a specified load of 500pF, assuming the bus rate is 2MHz. The slow transition output feature of PA6 and PA7, along with that of PB1 and PB2, can be enabled or disabled by software. Both PA6 and PA7 pins have Schmitt trigger input for better noise immunity. V_{IH} and V_{IL} are specified at 2.4V and 0.8V, respectively.

The slow transition feature of PA6 and PA7 pins can be enabled or disabled by software. Once enabled, slow transition feature is applied to both pins while in output mode.

1.5.6 PB0-PB5

NOTE

I/O lines PB2 to PB5 are not available on the 16-pin package.

These six I/O lines comprise Port B. PB0, PB3 to PB5 are push-pull I/O lines with pull-down resistor. PB1 and PB2 are open-drain I/O lines with pull-up resistor.

The state of any line is software programmable and is configured as an input during power-on or reset. I/O lines PB1 and PB2 have software programmable pull-up device whereas PB0, PB3 to PB5 have software programmable pull-down device, by a mask option. Pull-up devices on PB1 and PB2 lines once enabled are always enabled regardless of pin direction configuration; unlike pull-down devices on PB0, PB3-PB5 lines, which are activated only when the pin is configured as input pin.

Similar to PA6 and PA7, PB1 also has a slow output falling transition feature when configured as an output line. PB1 has 25mA sink capability at 0.5V V_{OL} .

PB2 output is one clock cycle (250ns if bus rate is 2MHz) late than other I/O pins if slow output transition feature is enabled. PB2 has 25mA sink capability at 0.5V V_{OL} .

NOTE

For the 16-pin package, PB1 and PB2 are bonded to the same pin and is labelled PB1. This PB1 has 50mA sink capability is slow transition feature is enabled and if they are written with the same value at the same write cycle. The falling transition time of PB1 is set at 250ns typical at a specified load of 50pF, assuming that the bus rate is 2MHz. The slow transition feature on this PB1 pin is longer than PB1 pin for the 20-pin package.



NOTE

If Port Data Register PB1 and PB2 are not written with the same value, PB1 pin on the 16-pin package will sink 25 mA only and the output transition time will be shorter.

SECTION 2 MEMORY

2.1 MEMORY MAP

The MC68HC05LJ5 has 4K-bytes of addressable memory consisting 32 bytes of I/O, 64 bytes of user RAM, and 1296 bytes of user ROM, as shown in **Figure 2-1**.

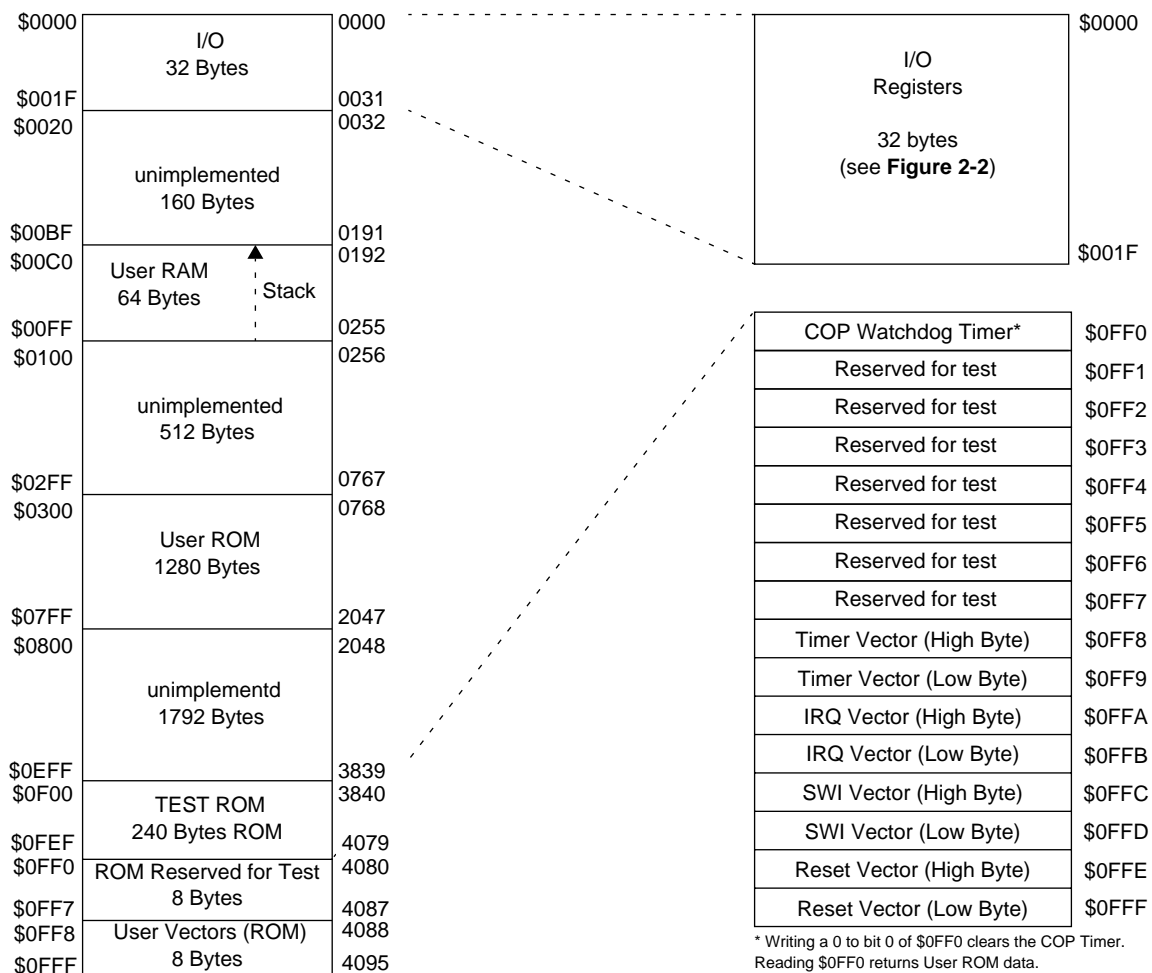


Figure 2-1. MC68HC05LJ5 Memory Map

2.2 I/O AND CONTROL REGISTERS

The I/O and Control Registers reside in locations \$0000-\$001F. The overall organization of these registers is shown in **Figure 2-2**. The bit assignments for each register are shown in **Figure 2-3** and **Figure 2-4**. Reading from unimplemented bits will return unknown states, and writing to unimplemented bits will be ignored.

Port A Data Register	\$0000
Port B Data Register	\$0001
unimplemented (2 bytes)	
Port A Data Direction Register	\$0004
Port B Data Direction Register	\$0005
unimplemented (2 bytes)	
Timer Control & Status Register	\$0008
Timer Counter Register	\$0009
IRQ Control & Status Register	\$000A
unimplemented (5 bytes)	
Port A Pull-down/up Register	\$0010
Port B Pull-down/up Register	\$0011
unimplemented (13 bytes)	
Reserved	\$001F

Figure 2-2. I/O Registers Memory Map

2.3 RAM

The User RAM consists of 64 bytes (including the stack), located from \$00C0 to \$00FF. The stack begins at address \$00FF and proceeds down to \$00C0. Using the stack area for data storage or temporary work locations requires care to prevent it from being overwritten due to stacking from an interrupt or subroutine call.

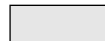
2.4 ROM

There are a total of 1296 bytes of user ROM on-chip. This includes 1280 bytes of user ROM from locations \$0300 to \$07FF for user program storage and 16 bytes for user vectors from locations \$0FF0 to \$0FFF. There are a total of 240 bytes of Internal Test ROM on chip at locations \$0F00 to \$0FEF.

2.5 I/O REGISTERS SUMMARY

ADDR	REGISTER	R/W	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
\$0000	Port A Data PORTA	R	PA7	PA6	PA5	PA4	PA3	PA2	PA1	PA0
		W								
\$0001	Port B Data PORTB	R	0	0	PB5	PB4	PB3	PB2	PB1	PB0
		W								
\$0002	<i>Unimplemented</i>	R								
		W								
\$0003	<i>Unimplemented</i>	R								
		W								
\$0004	Port A Data Direction DDRA	R	DDRA7	DDRA6	DDRA5	DDRA4	DDRA3	DDRA2	DDRA1	DDRA0
		W								
\$0005	Port B Data Direction DDRB	R	SLOWE	0	DDRB5	DDRB4	DDRB3	DDRB2	DDRB1	DDRB0
		W								
\$0006	<i>Unimplemented</i>	R								
		W								
\$0007	<i>Unimplemented</i>	R								
		W								
\$0008	MFT Ctrl/Status TCSR	R	TOF	RTIF	TOFE	RTIE	0	0	RT1	RT0
		W					TOFR	RTIFR		
\$0009	MFT Counter TCNT	R	TMR7	TMR6	TMR5	TMR4	TMR3	TMR2	TMR1	TMR0
		W								
\$000A	IRQ Control/Status ICSR	R	IRQE	IRQE1	0	0	IRQF	IRQF1	0	0
		W								IRQR
\$000B	<i>Unimplemented</i>	R								
		W								
\$000C	<i>Unimplemented</i>	R								
		W								
\$000D	<i>Unimplemented</i>	R								
		W								
\$000E	<i>Unimplemented</i>	R								
		W								
\$000F	<i>Unimplemented</i>	R								
		W								

unimplemented bits

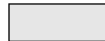


reserved bits


Figure 2-3. I/O Registers \$0000-\$000F

ADDR	REGISTER	R/W	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
\$0010	Port A Pull-down/up PDURA	R								
		W	PURA7	PURA6	PDRA5	PDRA4	PDRA3	PDRA2	PDRA1	PDRA0
\$0011	Port B Pull-down/up PDURB	R								
		W			PDRB5	PDRB4	PDRB3	PURB2	PURB1	PDRB0
\$0012	<i>Unimplemented</i>	R								
		W								
\$0013	<i>Unimplemented</i>	R								
		W								
\$0014	<i>Unimplemented</i>	R								
		W								
\$0015	<i>Unimplemented</i>	R								
		W								
\$0016	<i>Unimplemented</i>	R								
		W								
\$0017	<i>Unimplemented</i>	R								
		W								
\$0018	<i>Unimplemented</i>	R								
		W								
\$0019	<i>Unimplemented</i>	R								
		W								
\$001A	<i>Unimplemented</i>	R								
		W								
\$001B	<i>Unimplemented</i>	R								
		W								
\$001C	<i>Unimplemented</i>	R								
		W								
\$001D	<i>Unimplemented</i>	R								
		W								
\$001E	<i>Unimplemented</i>	R								
		W								
\$001F	<i>Unimplemented</i>	R								
		W								

unimplemented bits



reserved bits



Figure 2-4. I/O Registers \$0010-\$001F

SECTION 3 CENTRAL PROCESSING UNIT

The MC68HC05LJ5 has an 4k-bytes memory map. The stack has only 64 bytes. Therefore, the stack pointer has been reduced to only 6 bits and will only decrement down to \$00C0 and then wrap-around to \$00FF. All other instructions and registers behave as described in this chapter.

3.1 REGISTERS

The MCU contains five registers which are hard-wired within the CPU and are not part of the memory map. These five registers are shown in **Figure 3-1** and are described in the following paragraphs.

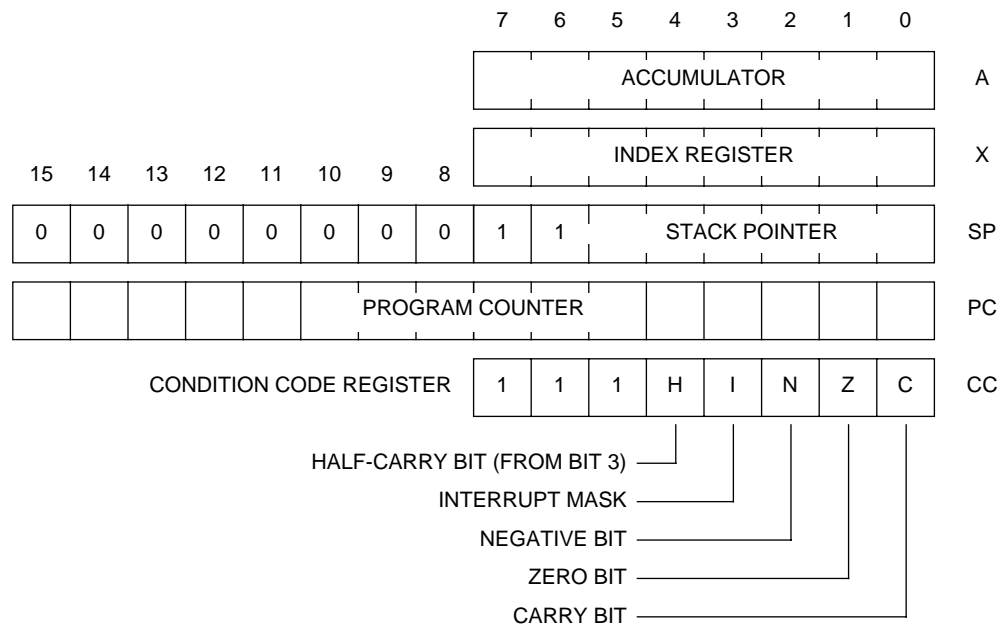


Figure 3-1. MC68HC05 Programming Model

3.2 ACCUMULATOR (A)

The accumulator is a general purpose 8-bit register as shown in **Figure 3-1**. The CPU uses the accumulator to hold operands and results of arithmetic calculations or non-arithmetic operations. The accumulator is not affected by a reset of the device.

3.3 INDEX REGISTER (X)

The index register shown in **Figure 3-1** is an 8-bit register that can perform two functions:

- Indexed addressing
- Temporary storage

In indexed addressing with no offset, the index register contains the low byte of the operand address, and the high byte is assumed to be \$00. In indexed addressing with an 8-bit offset, the CPU finds the operand address by adding the index register content to an 8-bit immediate value. In indexed addressing with a 16-bit offset, the CPU finds the operand address by adding the index register content to a 16-bit immediate value.

The index register can also serve as an auxiliary accumulator for temporary storage. The index register is not affected by a reset of the device.

3.4 STACK POINTER (SP)

The stack pointer shown in **Figure 3-1** is a 16-bit register. In MCU devices with memory space less than 64k-bytes the unimplemented upper address lines are ignored. The stack pointer contains the address of the next free location on the stack. During a reset or the reset stack pointer (RSP) instruction, the stack pointer is set to \$00FF. The stack pointer is then decremented as data is pushed onto the stack and incremented as data is pulled off the stack.

When accessing memory, the ten most significant bits are permanently set to 0000000011. The six least significant register bits are appended to these ten fixed bits to produce an address within the range of \$00FF to \$00C0. Subroutines and interrupts may use up to 64(\$C0) locations. If 64 locations are exceeded, the stack pointer wraps around and overwrites the previously stored information. A subroutine call occupies two locations on the stack and an interrupt uses five locations.

3.5 PROGRAM COUNTER (PC)

The program counter shown in **Figure 3-1** is a 16-bit register. In MCU devices with memory space less than 64k-bytes the unimplemented upper address lines are ignored. The program counter contains the address of the next instruction or operand to be fetched.

Normally, the address in the program counter increments to the next sequential memory location every time an instruction or operand is fetched. Jump, branch, and interrupt operations load the program counter with an address other than that of the next sequential location.

3.6 CONDITION CODE REGISTER (CCR)

The CCR shown in **Figure 3-1** is a 5-bit register in which four bits are used to indicate the results of the instruction just executed. The fifth bit is the interrupt mask. These bits can be individually tested by a program, and specific actions can be taken as a result of their states. The condition code register should be thought of as having three additional upper bits that are always ones. Only the interrupt mask is affected by a reset of the device. The following paragraphs explain the functions of the lower five bits of the condition code register.

3.6.1 Half Carry Bit (H-Bit)

When the half-carry bit is set, it means that a carry occurred between bits 3 and 4 of the accumulator during the last ADD or ADC (add with carry) operation. The half-carry bit is required for binary-coded decimal (BCD) arithmetic operations.

3.6.2 Interrupt Mask (I-Bit)

When the interrupt mask is set, the internal and external interrupts are disabled. Interrupts are enabled when the interrupt mask is cleared. When an interrupt occurs, the interrupt mask is automatically set after the CPU registers are saved on the stack, but before the interrupt vector is fetched. If an interrupt request occurs while the interrupt mask is set, the interrupt request is latched. Normally, the interrupt is processed as soon as the interrupt mask is cleared.

A return from interrupt (RTI) instruction pulls the CPU registers from the stack, restoring the interrupt mask to its state before the interrupt was encountered. After any reset, the interrupt mask is set and can only be cleared by the Clear I-Bit (CLI), or WAIT instructions.

3.6.3 Negative Bit (N-Bit)

The negative bit is set when the result of the last arithmetic operation, logical operation, or data manipulation was negative. (Bit 7 of the result was a logical one.)

The negative bit can also be used to check an often tested flag by assigning the flag to bit 7 of a register or memory location. Loading the accumulator with the contents of that register or location then sets or clears the negative bit according to the state of the flag.

3.6.4 Zero Bit (Z-Bit)

The zero bit is set when the result of the last arithmetic operation, logical operation, data manipulation, or data load operation was zero.



3.6.5 Carry/Borrow Bit (C-Bit)

The carry/borrow bit is set when a carry out of bit 7 of the accumulator occurred during the last arithmetic operation, logical operation, or data manipulation. The carry/borrow bit is also set or cleared during bit test and branch instructions and during shifts and rotates. This bit is neither set by an INC nor by a DEC instruction.

SECTION 4 INTERRUPTS

The CPU can be interrupted in five different ways:

- Non-maskable Software Interrupt Instruction (SWI)
- External Asynchronous Interrupt ($\overline{\text{IRQ}}$)
- Optional External Interrupt on PA0-PA3 (mask option)
- External Interrupt on PA7
- Internal Timer Interrupt

4.1 CPU INTERRUPT PROCESSING

Interrupts cause the processor to save register contents on the stack and to set the interrupt mask (I-bit) to prevent additional interrupts. Unlike RESET, hardware interrupts do not cause the current instruction execution to be halted, but are considered pending until the current instruction is complete.

If interrupts are not masked (I-bit in the CCR is clear) and the corresponding interrupt enable bit is set the processor will proceed with interrupt processing. Otherwise, the next instruction is fetched and executed. If an interrupt occurs the processor completes the current instruction, then stacks the current CPU register states, sets the I-bit to inhibit further interrupts, and finally checks the pending hardware interrupts. If more than one interrupt is pending following the stacking operation, the interrupt with the highest vector location shown in **Table 4-1** will be serviced first. The SWI is executed the same as any other instruction, regardless of the I-bit state.

When an interrupt is to be processed the CPU fetches the address of the appropriate interrupt software service routine from the vector table at locations \$07F8 to \$07FF as defined in **Table 4-1**.

Table 4-1. Vector Address for Interrupts and Reset

Register	Flag Name	Interrupts	CPU Interrupt	Vector Address
N/A	N/A	Reset	$\overline{\text{RESET}}$	\$0FFE-\$0FFF
N/A	N/A	Software	SWI	\$0FFC-\$0FFD
ICSR	IRQF/IRQF1	External Interrupt	$\overline{\text{IRQ}}$	\$0FFA-\$0FFB
TCSR	TOF	Timer Overflow	TIMER	\$0FF8-\$0FF9
TCSR	RTIF	Real Time Interrupt	TIMER	\$0FF8-\$0FF9

An RTI instruction is used to signify when the interrupt software service routine is completed. The RTI instruction causes the register contents to be recovered from the stack and normal processing to resume at the next instruction that was to be executed when the interrupt took place. **Figure 4-1** shows the sequence of events that occur during interrupt processing.

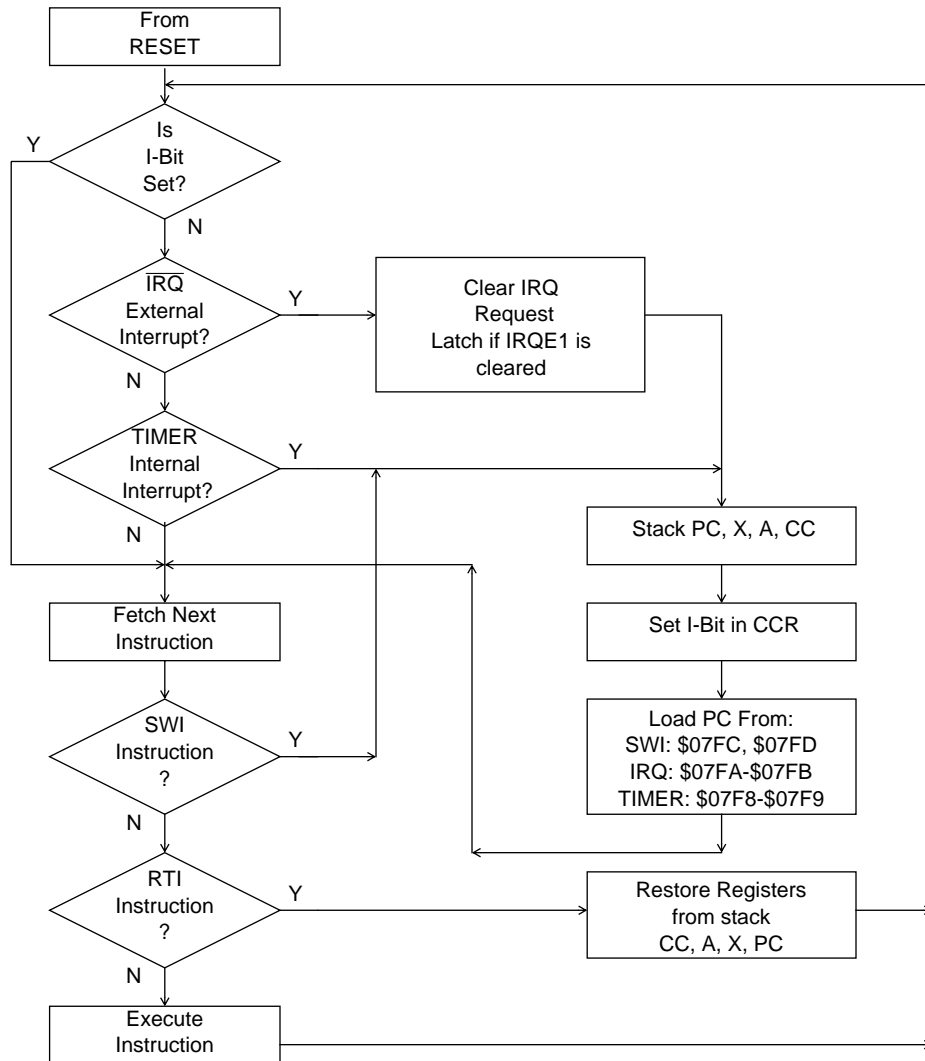


Figure 4-1. Interrupt Processing Flowchart

4.2 RESET INTERRUPT SEQUENCE

The RESET function is not in the strictest sense an interrupt; however, it is acted upon in a similar manner as shown in **Figure 4-1**. A low level input on the RESET pin or an internally generated RST signal causes the program to vector to its starting address which is specified by the contents of memory locations \$0FFE and \$0FFF. The I-bit in the condition code register is also set.

4.3 SOFTWARE INTERRUPT (SWI)

The SWI is an executable instruction and a non-maskable interrupt since it is executed regardless of the state of the I-bit in the CCR. As with any instruction, interrupts pending during the previous instruction will be serviced before the SWI opcode is fetched. The interrupt service routine address is specified by the contents of memory locations \$0FFC and \$0FFD.

4.4 HARDWARE INTERRUPTS

All hardware interrupts except RESET are maskable by the I-bit in the CCR. If the I-bit is set, all hardware interrupts (internal and external) are disabled. Clearing the I-bit enables the hardware interrupts. There are two types of hardware interrupts which are explained in the following sections.

4.5 EXTERNAL INTERRUPT ($\overline{\text{IRQ}}$)

Interrupts from external pins are available on:

- $\overline{\text{IRQ}}$ pin
- PA0 to PA3 pins (enabled by mask option)
- PA7 pin

4.5.1 $\overline{\text{IRQ}}$, PA0, PA1, PA2, and PA3 Pins

If “edge-only” sensitivity is chosen by mask option, the IRQ interrupt is sensitive to the following cases:

1. Falling edge on the $\overline{\text{IRQ}}$ pin.
2. Rising edge on any PA0-PA3 pin with IRQ enabled (via mask option).

If “edge-and-level” sensitivity is chosen, the IRQ interrupt is sensitive to the following cases:

1. Low level on the $\overline{\text{IRQ}}$ pin.
2. Falling edge on the $\overline{\text{IRQ}}$ pin.
3. High level on any PA0-PA3 pin with IRQ enabled (via mask option).
4. Rising edge on any PA0-PA3 pin with IRQ enabled (via mask option).

The IRQE enable bit controls whether an active IRQF flag can generate an IRQ interrupt sequence. This interrupt is serviced by the interrupt service routine located at the address specified by the contents of \$0FFA and \$0FFB.

The IRQ latch is automatically cleared by entering the interrupt service routine if IRQE1 enable bit is cleared. If IRQE1 enable bit is also set, the only way of clearing IRQF is by writing a logic one to the IRQR acknowledge bit. Writing a logic one to the IRQR acknowledge bit in the ICSR is the other way of clearing IRQF flag, regardless of the status of the IRQE1 bit, besides IRQ vector fetch. This conditional reset of IRQF flag provides a way for the user to differentiate the interrupt sources from IRQ and IRQ1 latches and also to make it HC05J1A compatible if

PA7 interrupt is not used. As long as the output state of the IRQF flag bit is active the CPU will continuously re-enter the IRQ interrupt sequence until the active state is removed or the IRQE enable bit is cleared.

4.5.2 PA7 Pin

PA7 interrupt source, if enabled by IRQE1 enable bit, triggers IRQ interrupt on PA7 falling edge only. The IRQ1 latch (IRQF1 flag) can ONLY be cleared by writing a logic one to the IRQR1 acknowledge bit in the ICSR. IRQ vector fetch can NOT clear IRQF1 flag. IRQ interrupt caused by PA7 falling edge also vectors to \$0FFA and \$0FFB.

4.5.3 IRQ Control/Status Register (ICSR), \$0A

The IRQ interrupt function is controlled by the ICSR located at \$000A. All unused bits in the ICSR will read as logic zeros. The IRQF, IRQF1, IRQE1 bits are cleared and IRQE bit is set by reset.

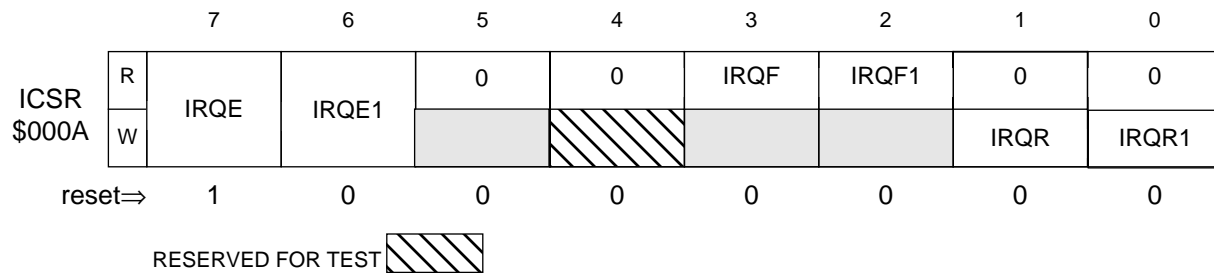


Figure 4-2. IRQ Status & Control Register

IRQR 1 - PA7 Interrupt Acknowledge

The IRQR1 acknowledge bit clears an IRQ interrupt triggered by a falling edge on PA7 by clearing the IRQ1 latch. The IRQR1 acknowledge bit will always read as a logic zero.

- 1 = Writing a logic one to the IRQR1 acknowledge bit will clear the IRQ1 latch.
- 0 = Writing a logic zero to the IRQR1 acknowledge bit will have no effect on the IRQ1 latch.

IRQR - IRQ Interrupt Acknowledge

The IRQR acknowledge bit clears an IRQ interrupt by clearing the IRQ latch. The IRQR acknowledge bit will always read as a logic zero.

- 1 = Writing a logic one to the IRQR acknowledge bit will clear the IRQ latch.
- 0 = Writing a logic zero to the IRQR acknowledge bit will have no effect on the IRQ latch.

IRQF1 - PA7 Interrupt Request Flag

Writing to the IRQF1 flag bit will have no effect on it. If the additional setting of IRQF1 flag bit is not cleared in the IRQ service routine and the IRQE1 enable bit remains set the CPU will re-enter the IRQ interrupt sequence continuously until either the IRQF1 flag bit or the IRQE1 enable bit is cleared. The IRQF1 latch is cleared by reset.

- 1 = Indicates that an IRQ request triggered by a falling edge on PA7 is pending.
- 0 = Indicates that no IRQ request triggered by a falling edge on PA7 is pending. The IRQF1 flag bit can ONLY be cleared by writing a logic one to the IRQR1 acknowledge bit. Doing so before exiting the service routine will mask out additional occurrences of the IRQF1.

IRQF - IRQ Interrupt Request Flag

Writing to the IRQF flag bit will have no effect on it. If the additional setting of IRQF flag bit is not cleared in the IRQ service routine and the IRQE enable bit remains set the CPU will re-enter the IRQ interrupt sequence continuously until either the IRQF flag bit or the IRQE enable bit is clear. The IRQF latch is cleared by reset.

- 1 = Indicates that an IRQ request is pending.
- 0 = Indicates that no IRQ request triggered by pins PA0-3 or \overline{IRQ} is pending. The IRQF flag bit is cleared once the IRQ vector is fetched AND if IRQE1 is also cleared. If IRQE1 is set, then the only way of clearing IRQF flag is by writing a logic one to IRQR bit. The IRQF flag bit can be cleared, regardless of the status of the IRQE1 bit, by writing a logic one to the IRQR acknowledge bit to clear the IRQ latch and also conditioning the external IRQ sources to be inactive (if the level sensitive interrupts are enabled via mask option). Doing so before exiting the service routine will mask out additional occurrences of the IRQF.

IRQE1 - PA7 Interrupt Enable

The IRQE1 bit enables/disables the IRQF1 flag bit to initiate an IRQ interrupt sequence.

- 1 = Enables IRQF1 interrupt, that is, the IRQF1 flag bit can generate an interrupt sequence. Execution of the STOP or WAIT instructions will leave the IRQE1 bit to be UNAFFECTED.
- 0 = The IRQF1 flag bit cannot generate an interrupt sequence. Reset clears the IRQE1 enable bit, thereby disabling PA7 interrupts.

IRQE - IRQ Interrupt Enable

The IRQE bit enables/disables the IRQF flag bit to initiate an IRQ interrupt sequence.

- 1 = Enables IRQF interrupt, that is, the IRQF flag bit can generate an interrupt sequence. Reset sets the IRQE enable bit, thereby enabling IRQ interrupts once the I-bit is cleared. Execution of the STOP or WAIT instructions causes the IRQE bit to be set in order to allow the external IRQ to exit these modes.
- 0 = The IRQF flag bit cannot generate an interrupt sequence.

4.5.4 Optional External Interrupts (PA0-PA3)

The IRQ interrupt can also be triggered by the inputs on the PA0 to PA3 port pins if enabled by a single mask option. If enabled, the lower four bits of Port A can activate the IRQ interrupt function, and the interrupt operation will be the same as for inputs to the $\overline{\text{IRQ}}$ pin. This mask option of PA0-3 interrupt allow all of these input pins to be OR'ed with the input present on the $\overline{\text{IRQ}}$ pin. All PA0 to PA3 pins must be selected as a group as an additional IRQ interrupt. All the PA0-3 interrupt sources are also controlled by the IRQE enable bit.

NOTE

The BIH and BIL instructions will only apply to the level on the $\overline{\text{IRQ}}$ pin itself, and not to the output of the logic OR function with the PA0 to PA3 pins. The state of the individual Port A pins can be checked by reading the appropriate Port A pins as inputs.

NOTE

If enabled, the PA0 to PA3 and PA7 pins will cause an IRQ interrupt regardless of whether these pins are configured as inputs or outputs.

4.6 TIMER INTERRUPT (TIMER)

The TIMER interrupt is generated by the multi-function timer when either a timer overflow or a real time interrupt has occurred as described in **Section 8**. The interrupt flags and enable bits for the Timer interrupts are located in the Timer Control/Status Register (TCSR) located at \$0008. The I-bit in the CCR must be clear in order for the TIMER interrupt to be enabled. Either of these two interrupts will vector to the same interrupt service routine located at the address specified by the contents of memory locations \$0FF8 and \$0FF9.

SECTION 5 RESETS

The MCU can be reset from five sources: one external input and four internal restart conditions.

- Initial power up of device (power on reset)
- A logic zero applied to the $\overline{\text{RESET}}$ pin (external reset).
- Timeout of the COP watchdog (COP reset)
- Low voltage applied to the device (LVR reset)
- Fetch of an opcode from an address not in the memory map (illegal address reset)

5.1 EXTERNAL RESET ($\overline{\text{RESET}}$)

The $\overline{\text{RESET}}$ pin is the only external source of a reset. This pin is connected to a Schmitt trigger input gate to provide an upper and lower threshold voltage separated by a minimum amount of hysteresis. This external reset occurs whenever the $\overline{\text{RESET}}$ pin is pulled below the lower threshold and remains in reset until the $\overline{\text{RESET}}$ pin rises above the upper threshold. This active low input will generate the RST signal and reset the CPU and peripherals. This pin is also an output pin whenever the LVR triggers an internal reset. Termination of the external $\overline{\text{RESET}}$ input or the internal COP Watchdog reset or LVR are the only reset sources that can alter the operating mode of the MCU.

5.2 INTERNAL RESETS

The four internally generated resets are the initial power-on reset function, the COP Watchdog Timer reset, the illegal address detector reset and the low voltage reset (LVR). Termination of the external $\overline{\text{RESET}}$ input or the internal COP Watchdog Timer or LVR are the only reset sources that can alter the operating mode of the MCU. The other internal resets will not have any effect on the mode of operation when their reset state ends.

5.2.1 Power-On Reset (POR)

The internal POR is generated on power-up to allow the clock oscillator to stabilize. The POR is strictly for power turn-on conditions and is not able to detect a drop in the power supply voltage (brown-out). There is an oscillator stabilization delay of 4064 internal processor bus clock cycles (PH2) after the oscillator becomes active.

The POR will generate the RST signal which will reset the CPU. If any other reset function is active at the end of this 4064 cycle delay, the RST signal will remain in the reset condition until the other reset condition(s) end.

5.2.2 Computer Operating Properly Reset (COPR)

The internal COPR reset is generated automatically (if the COP is enabled) by a time-out of the COP Watchdog Timer. This time-out occurs if the counter in the COP Watchdog Timer is not reset (cleared) within a specific time by a software reset sequence. The COP Watchdog Timer can be disabled by a mask option. Refer to **Section 8.2** for more information on this time-out feature. COP reset also forces the $\overline{\text{RESET}}$ pin low

The COPR will generate the RST signal which will reset the CPU and other peripherals. Also, the COPR will establish the mode of operation based on the state of the $\overline{\text{IRQ}}$ pin at the time the COPR signal ends. If the voltage on the $\overline{\text{IRQ}}$ pin is at the V_{TST} level, the state of the PB0 pin during the last rising edge of the $\overline{\text{RESET}}$ pin will determine which Test Mode (Internal or Expanded) the MCU will be in. If the voltage at the $\overline{\text{IRQ}}$ pin is in the normal operating range (V_{SS} to V_{DD}), the MCU will enter Single-Chip Mode when the COPR signal ends. If any other reset function is active at the end of the COPR reset signal, the RST signal will remain in the reset condition until the other reset condition(s) end.

5.2.3 Low Voltage Reset (LVR)

The internal LVR reset is generated when V_{DD} falls below the specified LVR trigger value V_{LVR} for at least one t_{CYC} . In typical applications, the power supply decoupling circuit will eliminate negative-going voltage glitches of less than one t_{CYC} . This reset will hold the MCU in the reset state until V_{DD} rises above V_{LVR} . Whenever V_{DD} is above V_{LVR} and below 4.5V, the MCU is guaranteed to operate although not within specification. The output from the LVR is connected directly to the internal reset circuitry and also forces the $\overline{\text{RESET}}$ pin low. The internal reset will be removed once the power supply voltage rises above V_{LVR} , at which time a normal power-on-reset sequence occurs.

5.2.4 Illegal Address Reset (ILADR)

The internal ILADR reset is generated when an instruction opcode fetch occurs from an address which is not implemented in the RAM (\$00C0 - \$00FF) nor ROM (\$0300-\$07FF). The ILADR will generate the RST signal which will reset the CPU and other peripherals. If any other reset function is active at the end of the ILADR reset signal, the RST signal will remain in the reset condition until the other reset condition(s) end. Notice that ILADR also forces the $\overline{\text{RESET}}$ pin low

SECTION 6 LOW POWER MODES

The MC68HC05LJ5 is capable of running in one of several low-power operating modes. The WAIT and STOP instructions provide two modes that reduce the power required for the MCU by stopping various internal clocks and/or the on-chip oscillator. The STOP and WAIT instructions are not normally used if the COP Watchdog Timer is enabled. A mask option is provided to convert the STOP instruction to a HALT, which is a WAIT-like instruction that does not halt the COP Watchdog Timer but has a recovery delay. The flow of the STOP, HALT, and WAIT modes are shown in **Figure 6-1**.

6.1 STOP INSTRUCTION

The STOP instruction can result in one of two modes of operation depending on the STOP mask option chosen. One option is for the STOP instruction to operate like the STOP in normal MC68HC05 family members and place the device in the STOP Mode. The other option is for the STOP instruction to behave like a WAIT instruction (except that the restart time will involve a delay) and place the device in the HALT Mode.

6.1.1 STOP Mode

Execution of the STOP instruction in this mode (as chosen by a mask option) places the MCU in its lowest power consumption mode. In the STOP Mode the internal oscillator is turned off, halting all internal processing, including the COP Watchdog Timer.

When the CPU enters STOP Mode the interrupt flags (TOF and RTIF) and the interrupt enable bits (TOFE and RTIE) in the TCSR are cleared by internal hardware to remove any pending timer interrupt requests and to disable any further timer interrupts. Execution of the STOP instruction automatically clears the I-bit in the Condition Code Register and sets the IRQE enable bit in the IRQ Control/Status Register so that the IRQ external interrupt is enabled. All other registers, including the other bits in the TCSR, and memory remain unaltered. All input/output lines remain unchanged.

The MCU can be brought out of the STOP Mode only by an IRQ external interrupt or an externally generated RESET or an LVR reset. When exiting the STOP Mode the internal oscillator will resume after a 4064 internal processor clock cycle oscillator stabilization delay.

NOTE

Execution of the STOP instruction with the STOP Mode Mask Option will cause the oscillator to stop and therefore disable the COP Watchdog Timer. If the COP Watchdog Timer is to be used, the STOP Mode should be changed to the HALT Mode by choosing the appropriate mask option. See Section 6.4 for more details.

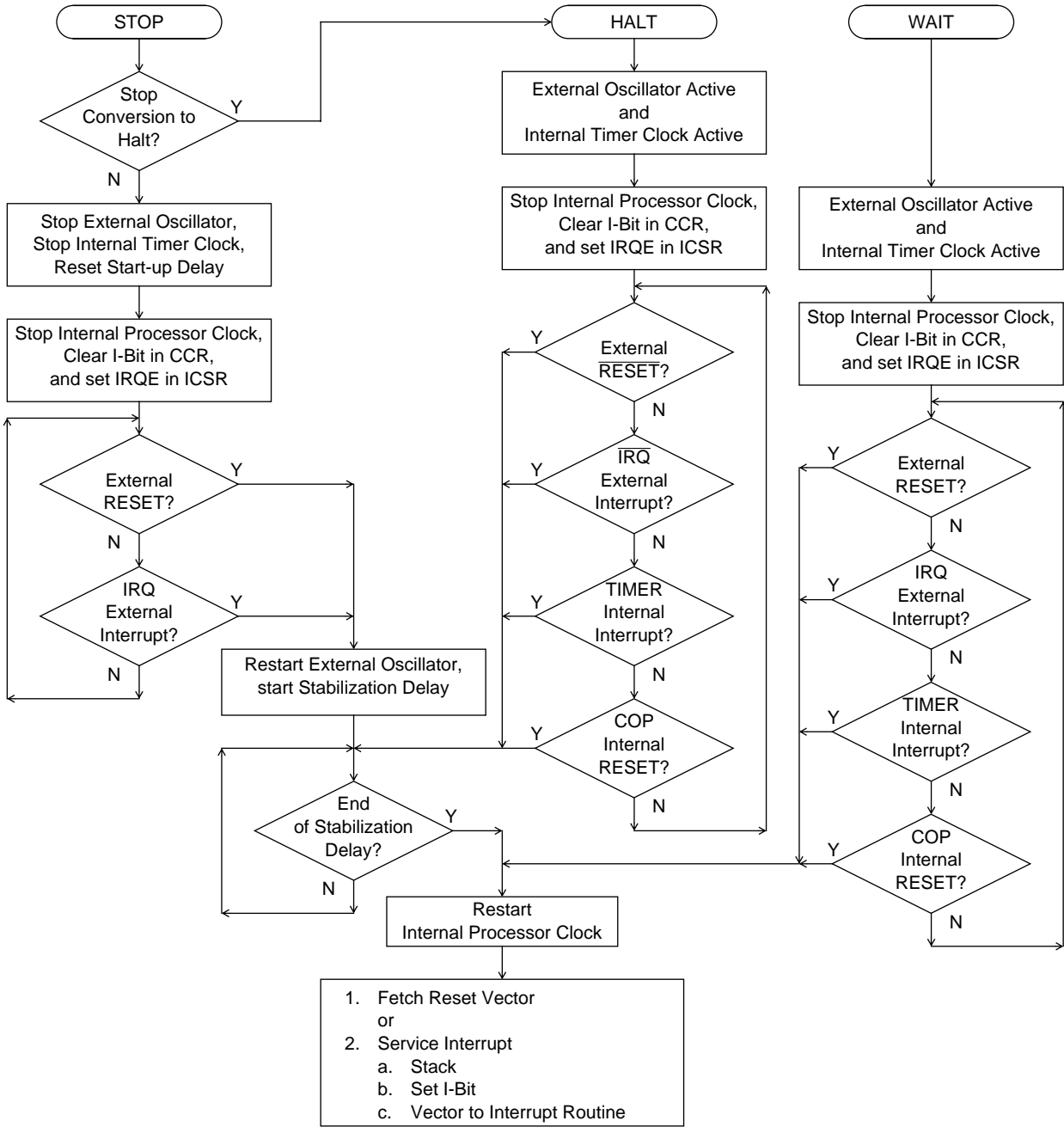


Figure 6-1. STOP/HALT/WAIT Flowcharts

6.1.2 HALT Mode

Execution of the STOP instruction in this mode (as chosen by a mask option) places the MCU in a low-power mode, which consumes more power than the STOP Mode. In the HALT Mode the internal processor clock is halted, suspending all processor and internal bus activity. Internal timer clocks remain active, permitting interrupts to be generated from the timer or a reset to be generated from the COP Watchdog Timer. Execution of the STOP instruction automatically clears the I-bit in the Condition Code Register and sets the IRQE enable bit in the IRQ Control/Status Register so that the IRQ external interrupt is enabled. All other registers, memory, and input/output lines remain in their previous states.

The HALT Mode may be exited when a Timer interrupt, an external IRQ, an LVR reset, or external $\overline{\text{RESET}}$ occurs. When exiting the HALT Mode the internal processor clock will resume after a delay of one to 4064 internal processor clock cycles. This varied delay time is due to the HALT Mode testing the oscillator stabilization delay timer (a feature of the STOP Mode) which has been free-running (a feature of the WAIT Mode).

NOTE

The HALT Mode is not intended for normal use, but is provided to keep the COP Watchdog Timer active should the STOP instruction opcode be inadvertently executed.

6.2 WAIT MODE

The WAIT instruction places the MCU in a low-power mode, which consumes more power than the STOP Mode. In the WAIT Mode the internal processor clock is halted, suspending all processor and internal bus activity. Internal timer clocks remain active, permitting interrupts to be generated from the timer or a reset to be generated from the COP Watchdog Timer. Execution of the WAIT instruction automatically clears the I-bit in the Condition Code Register and sets the IRQE enable bit in the IRQ Control/Status Register so that the IRQ external interrupt is enabled. All other registers, memory, and input/output lines remain in their previous states.

If timer interrupts are enabled, a TIMER interrupt will cause the processor to exit the WAIT Mode and resume normal operation. The Timer may be used to generate a periodic exit from the WAIT Mode. The WAIT Mode may also be exited when an external IRQ or an LVR reset or an external RESET occurs.

6.3 DATA-RETENTION MODE

If the LVR mask option is selected and since LVR kicks in whenever V_{DD} is below the specified LVR trigger voltage which is higher than that required of the Data Retention mode, the Data Retention mode will not exist. Data Retention Mode is only meaningful if LVR mask option is not selected.

The contents of RAM and CPU registers are retained at supply voltages as low as 2.0 VDC. This is called the data-retention mode where the data is held, but the device is not guaranteed to operate. The $\overline{\text{RESET}}$ pin must be held low during data-retention mode.

6.4 COP WATCHDOG TIMER CONSIDERATIONS

The COP Watchdog Timer is active in all modes of operation if enabled by a mask option. However, regardless of the mask option chosen, the COP Watchdog Timer will be disabled if the voltage on the $\overline{\text{IRQ}}$ pin equals or exceeds the V_{TST} voltage level. Thus, emulation of applications that do not service the COP should only be done with devices that have the COP Mask Option disabled. This prevents the voltage level on the $\overline{\text{IRQ}}$ pin from enabling the COP which would cause a reset and possibly change the operating mode of the device.

If the COP Watchdog Timer is selected by the mask option, any execution of the STOP instruction (either intentional or inadvertent due to the CPU being disturbed) will cause the oscillator to halt and prevent the COP Watchdog Timer from timing out unless the STOP to HALT conversion feature is enabled. Therefore, it is recommended that the STOP instruction should be converted to a HALT instruction if the COP Watchdog Timer is enabled.

If the COP Watchdog Timer is selected by the mask option, the COP will reset the MCU when it times out. Therefore, it is recommended that the COP Watchdog should be disabled for a system that must have intentional uses of the WAIT Mode for periods longer than the COP time-out period.

The recommended interactions and considerations for the COP Watchdog Timer, STOP instruction, and WAIT instruction are summarized in **Table 6-1**.

Table 6-1. COP Watchdog Timer Recommendations

IF the following conditions exist:			THEN the COP Watchdog Timer should be as follows:
Voltage on $\overline{\text{IRQ}}$ Pin	STOP Instruction	WAIT Time	
less than V_{TST}	converted to HALT by mask option	WAIT Time less than COP Time-Out	Enable or disable COP by mask option
less than V_{TST}	converted to HALT by mask option	WAIT Time more than COP Time-Out	Disable COP by mask option
less than V_{TST}	Acts as STOP	any length WAIT Time	Disable COP by mask option

SECTION 7 INPUT/OUTPUT PORTS

In the normal operating mode there are 14 usable bidirectional I/O lines arranged as one 8-bit I/O port (Port A), and one 6-bit I/O port (Port B). The individual bits in these ports are programmable as either inputs or outputs under software control by the data direction registers (DDR's). Also, if enabled by a single mask option all Port A and Port B I/O pins may have individual software programmable pull-down or pull-up devices. Also, PA4-PA7 and PB1-PB2 pins have properties of sinking higher current; PA0-PA3 may function as additional $\overline{\text{IRQ}}$ interrupt input sources. Note that both PA6 and PA7 pins have Schmitt trigger input for better noise immunity. V_{IH} and V_{IL} specified at 2.4V and 0.8V, respectively.

7.1 SLOW OUTPUT FALLING-EDGE TRANSITION

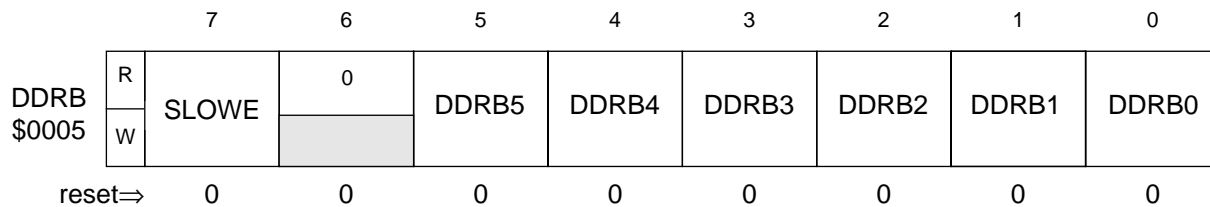


Figure 7-1. Port B Data Direction Register

SLOWE - Slow Transition Enabled

The slow transition feature is controlled by the SLOWE bit of DDRB (Port B Data Direction Register).

- 1 = Enables the slow falling-edge output transition feature on the four I/O lines: PA6, PA7, PB1, and PB2. If the pin is configured as an output pin.
- 0 = Disables slow falling-edge output transition feature on the four I/O lines: PA6, PA7, PB1, and PB2. Default value of SLOWE bit is cleared.

7.2 PORT A

Port A is an 8-bit bi-directional port which shares five of its pins with the IRQ interrupt system as shown in **Figure 7-2**. Note that both PA6 and PA7 pins have Schmitt trigger input for better noise immunity. Only PA6 and PA7 are of open-drained type with slow output transition feature. Each Port A pin is controlled by the corresponding bits in a data direction register, a data register, and a pull-down/up register. The Port A Data Register is located at address \$0000. The Port A

Data Direction Register (DDRA) is located at address \$0004. The Port A Pull-down/up Register (PDURA) is located at address \$0010. Reset clears the DDRA and the PDURA. The Port A Data Register is unaffected by reset.

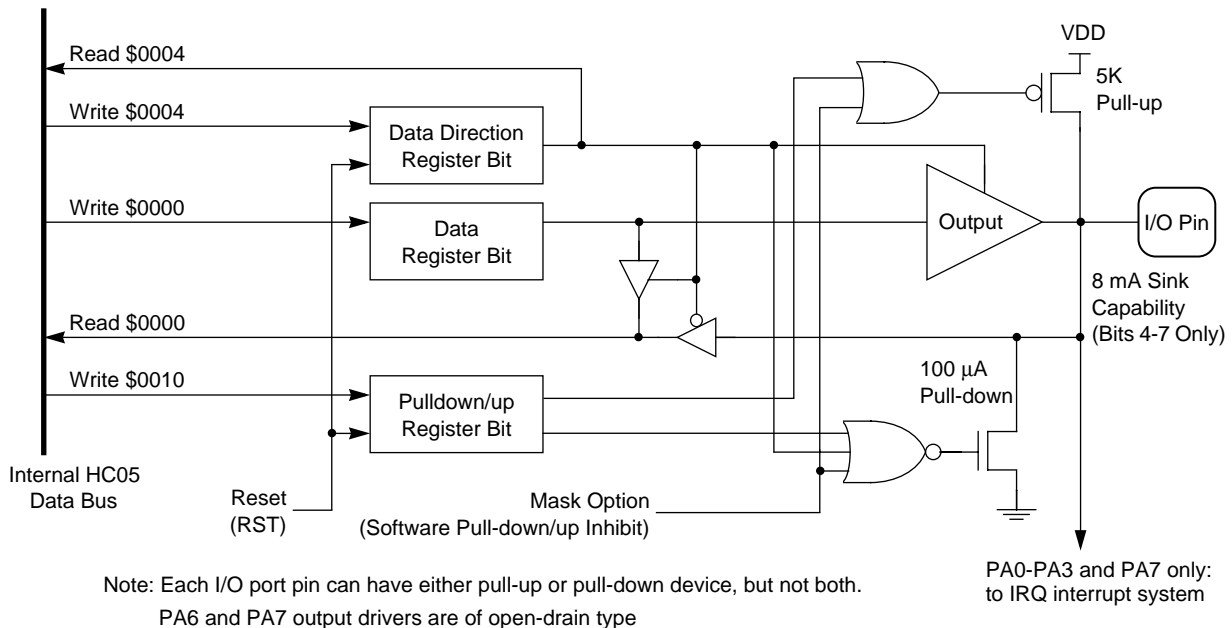


Figure 7-2. Port A I/O Circuitry

7.2.1 Port A Data Register

Each Port A I/O pin has a corresponding bit in the Port A Data Register. When a Port A pin is programmed as an output the state of the corresponding data register bit determines the state of the output pin. When a Port A pin is programmed as an input, any read of the Port A Data Register will return the logic state of the corresponding I/O pin. The Port A data register is unaffected by reset.

7.2.2 Port A Data Direction Register

Each Port A I/O pin may be programmed as an input by clearing the corresponding bit in the DDRA, or programmed as an output by setting the corresponding bit in the DDRA. The DDRA can be accessed at address \$0004. The DDRA is cleared by reset.

If configured as output pins, PA6 and PA7 have slow output falling-edge transition feature. The slow transition feature is controlled by the SLOWE bit of DDRB. SLOWE bit, if set and if the pin is configured as an output pin, enables the slow falling-edge output transition feature of all three I/O lines, PA6, PA7, and PB1.

7.2.3 Port A Pull-down/up Register

All Port A I/O pins may have software programmable pull-down/up devices enabled by the applicable mask option. If the pull-down/up mask option is selected, the pull-down/up is activated whenever the corresponding bit in the PDURA is clear. If the corresponding bit in the PDURA bit is set or the mask option for pull-down/up is not chosen, the pull-down/up will be disabled. A pull-down on an I/O pin is activated only if the I/O pin is programmed as an input whereas a Pull-up device on an I/O pin is always activated whenever enabled, regardless of port direction.

The PDURA is a write-only register. Any reads of location \$0010 will return undefined results. Since reset clears both the DDRA and the PDURA, all pins will initialize as inputs with the pull-down active and pull-up devices active (if enabled by mask option).

Typical value of port A pull-up is 5K Ω .

7.2.4 Port A Drive Capability

The outputs for the upper four bits of Port A (PA4, PA5, PA6 and PA7) are capable of sinking approximately 8 mA of current to V_{SS} .

7.2.5 Port A I/O Pin Interrupts

The inputs to PA0, PA1, PA2, PA3 may be connected to the IRQ input of the CPU if enabled by a mask option. The input to PA7 is also connected to the IRQ input of the CPU, yet it is only enabled or disabled by software, not by mask option. PA7 interrupt capability is controlled by a set of control and status bits (IRQE1, IRQF1, IRQR1), different from the set of control and status bits for that of PA0-PA3 and \overline{IRQ} pin (IRQE, IRQF, IRQR) in the same ICSR (Interrupt Control and Status Register).

When connected as an alternate source of an IRQ interrupt, PA0-3 input pins will behave the same as the \overline{IRQ} pin itself, except that their active state is a logical one or a rising edge. The \overline{IRQ} pin has an active state that is a logical zero or a falling edge. PA7 interrupt occurs, if enabled, only upon the falling edge at the input.

If mask options for both level and edge sensitivity interrupts are chosen, the presence of a logic one or occurrence of a rising edge on any one of the lower four Port A pins will cause an IRQ interrupt request. If the edge-only sensitivity is selected, the occurrence of a rising edge on any one of the lower four Port A pins will cause an IRQ interrupt request. As long as any one of the lower four Port A IRQ inputs remains at a logic one level, the other of the lower four Port A IRQ inputs are effectively ignored.

NOTE

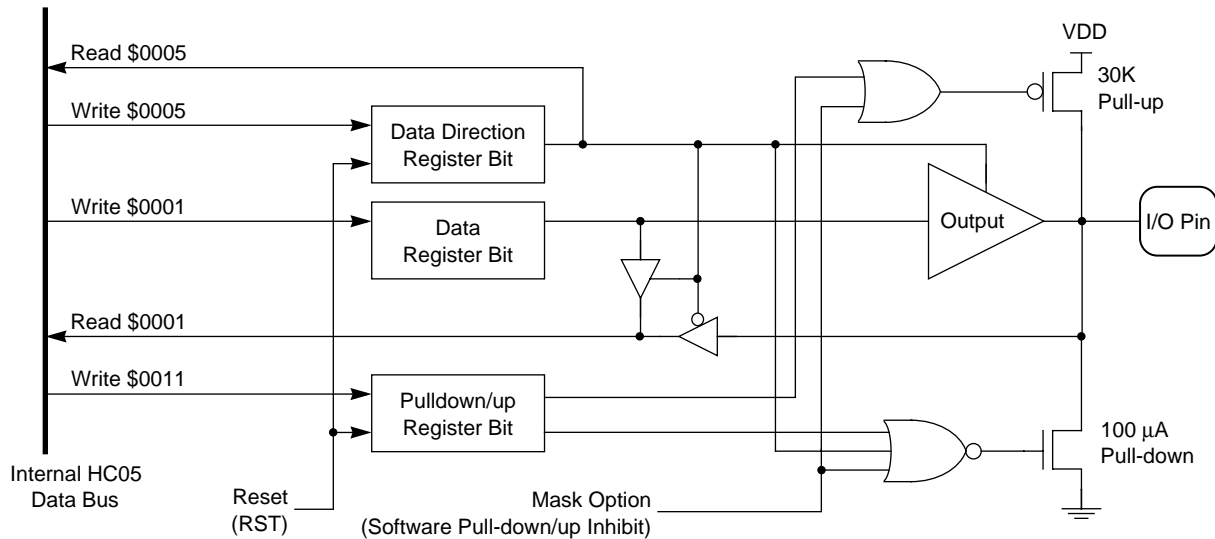
The BIH and BIL instructions will only apply to the level on the \overline{IRQ} pin itself, and not to the internal IRQ input to the CPU. Therefore BIH and BIL cannot be used to test the state of the lower four Port A input pins as a group nor that of PA7.

7.3 PORT B

Port B is a 6-bit bidirectional port which functions as shown in **Figure 7-3**. Each Port B pin is controlled by the corresponding bits in a data direction register, a data register, and a pull-down/up register. The Port B Data Register is located at address \$0001. The Port B Data Direction Register (DDRB) is located at address \$0005. The Port B Pull-down/up Register (PDURB) is located at address \$0011. Reset clears the DDRB and the PDURB. The Port B Data Register is unaffected by reset.

PB1 and PB2 are open-drained type I/Os, capable of typically sinking 25mA current each, at V_{OL} 0.5V max.

For the 16-pin package, PB1 and PB2 are connected together to form the pin labelled PB1 on the package. This PB1 pin will have a maximum sink current of 50mA if both PB1 and PB2 are written with the same value at the same write cycle.



Note: Each I/O port pin can have either pull-up or pull-down device, but not both.
PB1 and PB2 output drivers are of open-drain type

Figure 7-3. Port B I/O Circuitry

7.3.1 Port B Data Register

All Port B I/O pins have a corresponding bit in the Port B Data Register. When a Port B pin is programmed as an output the state of the corresponding data register bit determines the state of the output pin. When a Port B pin is programmed as an input, any read of the Port B Data Register will return the logic state of the corresponding I/O pin. The Port B data register is unaffected by reset. Unused bits 6 and 7 will always read as logic zeros, and any write to these bits will be ignored. The Port B data register is unaffected by reset.

7.3.2 Port B Data Direction Register

Port B I/O pins may be programmed as an input by clearing the corresponding bit in the DDRB, or programmed as an output by setting the corresponding bit in the DDRB. The DDRB can be accessed at address \$0005. Unused bits 6 and 7 will always read as logic zeros, and any write to these bits will be ignored. The DDRB is cleared by reset.

If configured as output pins, PB1 and PB2 have slow output falling-edge transition feature. The slow transition feature is controlled by the SLOWE bit of DDRB. SLOWE bit, if set and if the pin is configured as an output pin, enables the slow falling-edge output transition feature of all four I/O lines, PA6, PA7, PB1 and PB2.

For the 16-pin package type, care should be taken in using PB1 pin, which is bonded to two internal port B I/O lines PB1 and PB2, to constitute a 50 mA current sinking driver. Both PB1 and PB2 I/O lines are capable of sinking 25 mA. If they are written with the same logic 0 value in the same write cycle, PB1 pin will sink 50 mA. If they are written with different values in the same write cycle, PB1 pin will sink only 25 mA.

For the 20-pin package type, I/O lines PB1 and PB2 are not bonded to the same pin. Hence, to constitute a 50mA current sinking driver, PB1 and PB2 pins have to be tied together externally and controlled in the same way as in the 16-pin package type case.

Also, if the slow transition feature of pin PB1 is enabled, a combination of I/O lines PB1 and PB2, is also a combination of slow transition features of I/O lines PB1 and PB2. PB2 line falling-edge output transition occurs $t_{CYC}/2$ after the write cycle, with a standard I/O edge transition time. Whereas for PB1 line, the falling-edge transition occurring immediately after the write cycle, but with an edge transition time slower than standard I/Os, similar to PA6 and PA7 pins.

The net result is, for the 16-pin package type, since both PB1 and PB2 I/O lines are bonded to the same PB1 pin, the combination of delayed PB1 line sharp-edge output and the non-delayed slow transition output yields the desired slow output falling-edge transition.

For the 20-pin package, PB1 and PB2 pins should be tied externally to create a driver with the desired slow output falling-edge transition feature. If SLOWE is set and PB2 pin is not tied to PB1 pin, be advised that the output at PB2 changes state $t_{CYC}/2$ after the write cycle.

7.3.3 Port B Pull-down/up Register

All Port B I/O pins may have software programmable pull-down/up devices enabled by a mask option. If the pull-down/up mask option is selected, the pull-down/up is activated whenever the corresponding bit in the PDURB is clear. A pull-down on an I/O pin is activated only if the I/O pin is programmed as an input whereas a Pull-up device on an I/O pin is always activated whenever enabled, regardless of port direction.

The PDURB is a write-only register. Any reads of location \$0011 will return undefined results. Since reset clears both the DDRB and the PDURB, all pins will initialize as inputs with the pull-down devices active and pull-up devices active (if chosen via mask option).

Typical value of port B pull-up is 30K Ω .

7.4 I/O PORT PROGRAMMING

All I/O pins can be programmed as inputs or outputs, with or without pull-down/up devices.

7.4.1 Pin Data Direction

The direction of a pin is determined by the state of its corresponding bit in the associated port Data Direction Register (DDR). A pin is configured as an output if its corresponding DDR bit is set to a logic one. A pin is configured as an input if its corresponding DDR bit is cleared to a logic zero.

The data direction bits DDRB0 to DDRB2 and DDRA0 to DDRA7 are read/write bits which can be manipulated with read-modify-write instructions. At power-on or reset, all DDRs are cleared which configures all port pins as inputs. If the pull-down/up mask option is chosen, all pins will initially power-up with their software programmable pull-downs/ups enabled.

7.4.2 Output Pin

When an I/O pin is programmed as an output pin, the state of the corresponding data register bit will determine the state of the pin. The state of the data register bits can be altered by writing to address \$0000 for Port A and address \$0001 for Port B. Reads of the corresponding data register bit at address \$0000 or \$0001 will return the state of the data register bit (not the state of the I/O pin itself). Therefore bit manipulation is possible on all pins programmed as outputs.

If the corresponding bit in the pull-down/up register is clear (and the pull-down/up mask option is chosen), only output pins with pull-ups have an activated pull-up device connected to the pin. For those pins with pull-downs and configured as output pins, the pull-downs will be inactivated regardless of the state of the corresponding pull-down/up register bit. Since the pull-down/up register bits are write-only, bit manipulation should not be used on these register bits.

7.4.3 Input Pin

When an I/O pin is programmed as an input pin, the state of the pin can be determined by reading the corresponding data register bit. Any writes to the corresponding data register bit for an input pin will be ignored in the sense that the written value will not be reflected on the pin, rather it is only reflected in the port data register. Please refer to **Table 7-1** and **Table 7-2** for details.

If the corresponding bit in the pull-down/up register is clear (and the pull-down/up mask option is chosen) the input pin will also have an activated pull-down/up device. Since the pull-down/up register bits are write-only, bit manipulation should not be used on these register bits.

7.4.4 I/O Pin Transitions

A "glitch" can be generated on an I/O pin when changing it from an input to an output unless the data register is first preconditioned to the desired state before changing the corresponding DDR bit from a zero to a one.

If pull-downs are enabled by mask option, a floating input can be avoided by clearing the pull-down/up register bit before changing the corresponding DDR from a one to a zero. This will insure that the pull-down device will be activated before the I/O pin changes from a driven output to a pulled low/high input.

7.4.5 I/O Pin Truth Tables

Every pin on Port A and Port B may be programmed as an input or an output under software control as shown in **Table 7-1** and **Table 7-2**. All port I/O pins may also have software programmable pull-down/up devices if selected by the appropriate mask option.

Table 7-1. Port A I/O Pin Functions

DDRA	I/O Pin Mode	Accesses to PDURA at \$0010		Accesses to DDRA @ \$0004	Accesses to Data Register @ \$0000	
		Read	Write	Read/Write	Read	Write
0	IN, Hi-Z	U	PDURA0-7	DDRA0-7	I/O Pin PA0-7	*
1	OUT	U	PDURA0-7	DDRA0-7	PA0-7	PA0-7

U is undefined

* Does not affect input, but stored to data register

Table 7-2. Port B I/O Pin Functions

DDRB	I/O Pin Mode	Accesses to PDURB at \$0011		Accesses to DDRB @ \$0005	Accesses to Data Register @ \$0001	
		Read	Write	Read/Write	Read	Write
0	IN, Hi-Z	U	PDURB0-2	DDRB0-2	I/O Pin PB0-2	*
1	OUT	U	PDURB0-2	DDRB0-2	PB0-2	PB0-2

U is undefined

* Does not affect input, but stored to data register



SECTION 8 MULTI-FUNCTION TIMER

The MC68HC05LJ5 timer is a 15-stage multi-function ripple counter. The features include Timer Over Flow (TOF), Power-On Reset (POR), Real Time Interrupt (RTI), and COP Watchdog Timer.

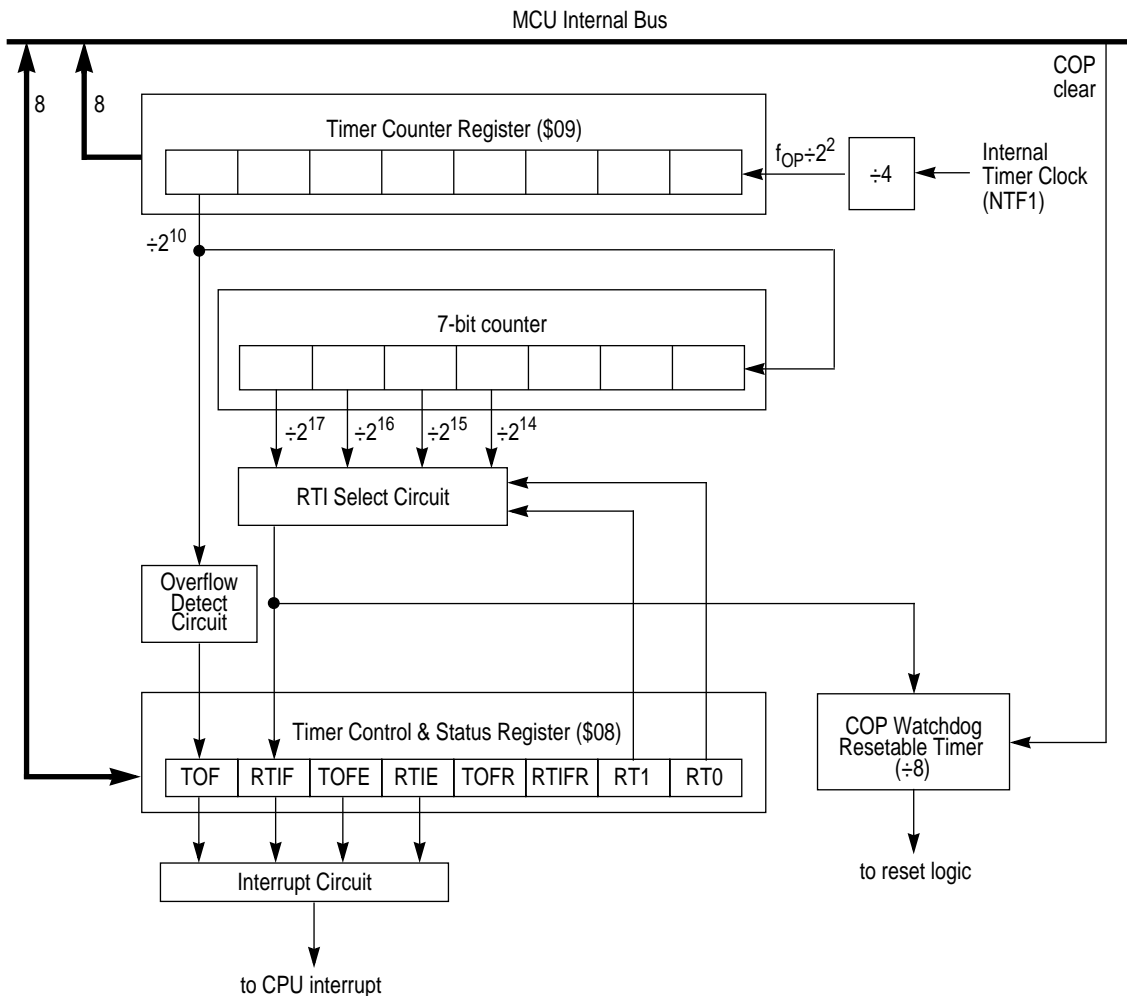


Figure 8-1. Multi-Function Timer Block Diagram

As shown in **Figure 8-1**, the Timer is driven by the timer clock, NTF1, divided by four (4). NTF1 has the same phase and frequency as the processor bus clock, PH2, but is not stopped by the WAIT or HALT Modes. This signal drives an 8-bit ripple counter. The value of this 8-bit ripple counter can be read by the CPU at any time by accessing the Timer Counter Register (TCR) at address \$09. A timer over-

flow function is implemented on the last stage of this counter, giving a possible interrupt at the rate of $f_{op}/1024$. This circuit is followed by four more stages, with the resulting clock ($f_{op}/16384$) driving the Real Time Interrupt circuit. The RTI circuit consists of three divider stages with a 1 of 4 selector. The output of the RTI circuit is further divided by eight to drive the optional COP Watchdog Timer circuit, which can be enabled by a mask option. The RTI rate selector bits, and the RTI and TOF enable bits and flags are located in the Timer Control and Status Register at location \$08.

The Real Time Interrupt circuit consists of a three stage divider and a 1 of 4 selector. The clock frequency that drives the RTI circuit is $f_{op}/2^{14}$ (or $f_{op}/16384$) with three additional divider stages giving a maximum interrupt period of $f_{op}/2^{17}$ (or $f_{op}/131072$).

The power-on cycle clears the entire counter chain and begins clocking the counter. After 4064 cycles, the power-on reset circuit is released which again clears the counter chain and allows the device to come out of reset. At this point, if \overline{RESET} is not asserted, the timer will start counting up from zero and normal device operation will begin. If \overline{RESET} is asserted at any time during operation the counter chain will be cleared.

8.1 TIMER REGISTERS

The 15-stage Multi-function Timer contains two registers: a Timer Counter Register and a Timer Control/Status Register.

8.1.1 Timer Counter Register (TCR), \$09

The Timer Counter Register is a read-only register which contains the current value of the 8-bit ripple counter at the beginning of the timer chain. This counter is clocked at f_{op} divided by 4 and can be used for various functions including a software input capture. Extended time periods can be attained using the TOF function to increment a temporary RAM storage location thereby simulating a 16-bit (or more) counter. The value of each bit of the TCR is shown in **Figure 8-2**. This register is cleared by reset.

		7	6	5	4	3	2	1	0
TCR \$09	R	TMR7	TMR6	TMR5	TMR4	TMR3	TMR2	TMR1	TMR0
	W								
Reset ⇒		0	0	0	0	0	0	0	0

Figure 8-2. Timer Counter Register

8.1.2 Timer Control/status Register (TCSR), \$08

The TCSR contains the timer interrupt flag bits, the timer interrupt enable bits, and the real time interrupt rate select bits. Bit 2 and bit 3 are write-only bits which will read as logical zeros. **Figure 8-3** shows the value of each bit in the TCSR following reset.

	7	6	5	4	3	2	1	0	
TCSR \$08	R	TOF	RTIF	TOFE	RTIE	0	0	RT1	RT0
	W					TOFR	RTIFR		
Reset ⇒	0	0	0	0	0	0	0	1	1

Figure 8-3. Timer Control/Status Register (TCSR)

TOF - Timer Overflow Flag

The TOF is a read-only flag bit.

- 1 = Set when the 8-bit ripple counter rolls over from \$FF to \$00. A TIMER Interrupt request will be generated if TOFE is also set.
- 0 = Reset by writing a logical one to the TOF acknowledge bit, TOFR. Writing to the TOF flag bit has no effect on its value. This bit is cleared by reset.

RTIF - Real Time Interrupt Flag

The RTIF is a read-only flag bit.

- 1 = Set when the output of the chosen (1 of 4 selections) Real Time Interrupt stage goes active. A TIMER Interrupt request will be generated if RTIE is also set.
- 0 = Reset by writing a logical one to the RTIF acknowledge bit, RTIFR. Writing to the RTIF flag bit has no effect on its value. This bit is cleared by reset.

TOFE - Timer Overflow Enable

The TOFE is an enable bit that allows generation of a TIMER Interrupt upon overflow of the Timer Counter Register.

- 1 = When set, the TIMER Interrupt is generated when the TOF flag bit is set.
- 0 = When cleared, no TIMER interrupt caused by TOF bit set will be generated. This bit is cleared by reset.

RTIE - Real Time Interrupt Enable

The RTIE is an enable bit that allows generation of a TIMER Interrupt by the RTIF bit.

- 1 = When set, the TIMER Interrupt is generated when the RTIF flag bit is set.
- 0 = When cleared, no TIMER interrupt caused by RTIF bit set will be generated. This bit is cleared by reset.

TOFR - Timer Overflow Acknowledge

The TOFR is an acknowledge bit that resets the TOF flag bit. This bit is unaffected by reset. Reading the TOFR will always return a logical zero.

- 1 = Clears the TOF flag bit.
- 0 = Does not clear the TOF flag bit.

RTIFR - Real Time Interrupt Acknowledge

The RTIFR is an acknowledge bit that resets the RTIF flag bit. This bit is unaffected by reset. Reading the RTIFR will always return a logical zero.

- 1 = Clears the RTIF flag bit.
- 0 = Does not clear the RTIF flag bit.

RT1:RT0 - Real Time Interrupt Rate Select

The RT0 and RT1 control bits select one of four taps for the Real Time Interrupt circuit. **Table 8-1** shows the available interrupt rates for two f_{OP} values. Both the RT0 and RT1 control bits are set by reset, selecting the lowest periodic rate and therefore the maximum time in which to alter these bits if necessary. Care should be taken when altering RT0 and RT1 if the time-out period is imminent or uncertain. If the selected tap is modified during a cycle in which the counter is switching, an RTIF could be missed or an additional one could be generated. To avoid problems, the COP should be cleared just prior to changing RTI taps.

Table 8-1. RTI and COP Rates at $f_{OP}=3.0\text{MHz}$

		Bus Frequency, $f_{BUS}=f_{OP}=2.0\text{ MHz}$		
RT1	RT0	Divide Ratio	RTI Rate	COP Reset Period (RTI x 8)
0	0	2^{14}	8.912ms	66ms
0	1	2^{15}	16.384ms	131ms
1	0	2^{16}	32.768ms	262ms
1	1	2^{17}	65.536ms	524ms

8.2 COP WATCHDOG TIMER

The COP (Computer Operating Properly) Watchdog Timer function is implemented on this device by using the output of the RTI circuit and further dividing it by eight. The minimum COP reset times are listed in **Table 8-1**. If the COP circuit times out, an internal reset is generated and the reset vector is fetched. Preventing a COP time-out is done by writing a logical zero to bit 0 of address \$0FF0 as shown in **Figure 8-4**. The COP register is shared with a Test ROM byte. This address location is not affected by any reset signals. Reading this location will return the Test ROM byte. When the COP is cleared, only the final divide by eight stage (output of the RTI) is cleared. The COP Watchdog Timer can be enabled/disabled by a mask option.

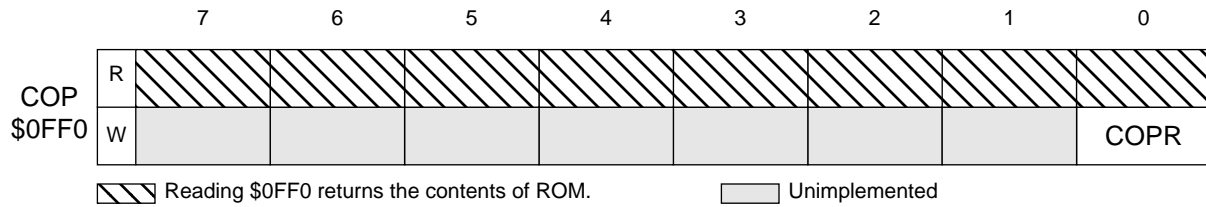


Figure 8-4. COP Watchdog Timer Location

8.3 OPERATION DURING STOP MODE

The timer system is cleared when going into STOP mode. When STOP is exited by an external interrupt or an LVR reset or an external $\overline{\text{RESET}}$, the internal oscillator will resume, followed by a 4064 internal processor oscillator stabilization delay. The timer system counter is then cleared and operation resumes. If chosen by a mask option, the STOP instruction will initiate HALT mode and the effects on the timer are as described in **Section 8.4**.

8.4 OPERATION DURING WAIT/HALT MODE

The CPU clock halts during the WAIT/HALT mode, but the timer remains active. If interrupts are enabled, a timer interrupt or custom periodic interrupt will cause the processor to exit the WAIT/HALT mode.



SECTION 9 INSTRUCTION SET

This section describes the addressing modes and instruction types.

9.1 ADDRESSING MODES

The CPU uses eight addressing modes for flexibility in accessing data. The addressing modes define the manner in which the CPU finds the data required to execute an instruction. The eight addressing modes are the following:

- Inherent
- Immediate
- Direct
- Extended
- Indexed, No Offset
- Indexed, 8-Bit Offset
- Indexed, 16-Bit Offset
- Relative

9.1.1 Inherent

Inherent instructions are those that have no operand, such as return from interrupt (RTI) and stop (STOP). Some of the inherent instructions act on data in the CPU registers, such as set carry flag (SEC) and increment accumulator (INCA). Inherent instructions require no memory address and are one byte long.

9.1.2 Immediate

Immediate instructions are those that contain a value to be used in an operation with the value in the accumulator or index register. Immediate instructions require no memory address and are two bytes long. The opcode is the first byte, and the immediate data value is the second byte.

9.1.3 Direct

Direct instructions can access any of the first 256 memory addresses with two bytes. The first byte is the opcode, and the second is the low byte of the operand address. In direct addressing, the CPU automatically uses \$00 as the high byte of the operand address. BRSET and BRCLR are three-byte instructions that use direct addressing to access the operand and relative addressing to specify a branch destination.

9.1.4 Extended

Extended instructions use only three bytes to access any address in memory. The first byte is the opcode; the second and third bytes are the high and low bytes of the operand address.

When using the Motorola assembler, the programmer does not need to specify whether an instruction is direct or extended. The assembler automatically selects the shortest form of the instruction.

9.1.5 Indexed, No Offset

Indexed instructions with no offset are one-byte instructions that can access data with variable addresses within the first 256 memory locations. The index register contains the low byte of the conditional address of the operand. The CPU automatically uses \$00 as the high byte, so these instructions can address locations \$0000–\$00FF.

Indexed, no offset instructions are often used to move a pointer through a table or to hold the address of a frequently used RAM or I/O location.

9.1.6 Indexed, 8-Bit Offset

Indexed, 8-bit offset instructions are two-byte instructions that can access data with variable addresses within the first 511 memory locations. The CPU adds the unsigned byte in the index register to the unsigned byte following the opcode. The sum is the conditional address of the operand. These instructions can access locations \$0000–\$01FE.

Indexed 8-bit offset instructions are useful for selecting the *k*th element in an *n*-element table. The table can begin anywhere within the first 256 memory locations and could extend as far as location 510 (\$01FE). The *k* value is typically in the index register, and the address of the beginning of the table is in the byte following the opcode.

9.1.7 Indexed, 16-Bit Offset

Indexed, 16-bit offset instructions are three-byte instructions that can access data with variable addresses at any location in memory. The CPU adds the unsigned byte in the index register to the two unsigned bytes following the opcode. The sum is the conditional address of the operand. The first byte after the opcode is the high byte of the 16-bit offset; the second byte is the low byte of the offset. These instructions can address any location in memory.

Indexed, 16-bit offset instructions are useful for selecting the *k*th element in an *n*-element table anywhere in memory.

As with direct and extended addressing, the Motorola assembler determines the shortest form of indexed addressing.

9.1.8 Relative

Relative addressing is only for branch instructions. If the branch condition is true, the CPU finds the conditional branch destination by adding the signed byte following the opcode to the contents of the program counter. If the branch condition is not true, the CPU goes to the next instruction. The offset is a signed, two's complement byte that gives a branching range of -128 to $+127$ bytes from the address of the next location after the branch instruction.

When using the Motorola assembler, the programmer does not need to calculate the offset, because the assembler determines the proper offset and verifies that it is within the span of the branch.

9.1.9 Instruction Types

The MCU instructions fall into the following five categories:

- Register/Memory Instructions
- Read-Modify-Write Instructions
- Jump/Branch Instructions
- Bit Manipulation Instructions
- Control Instructions

9.1.10 Register/Memory Instructions

Most of these instructions use two operands. One operand is in either the accumulator or the index register. The CPU finds the other operand in memory. **Table 9-1** lists the register/memory instructions.

Table 9-1. Register/Memory Instructions

Instruction	Mnemonic
Add Memory Byte and Carry Bit to Accumulator	ADC
Add Memory Byte to Accumulator	ADD
AND Memory Byte with Accumulator	AND
Bit Test Accumulator	BIT
Compare Accumulator	CMP
Compare Index Register with Memory Byte	CPX
EXCLUSIVE OR Accumulator with Memory Byte	EOR
Load Accumulator with Memory Byte	LDA
Load Index Register with Memory Byte	LDX
Multiply	MUL
OR Accumulator with Memory Byte	ORA
Subtract Memory Byte and Carry Bit from Accumulator	SBC
Store Accumulator in Memory	STA
Store Index Register in Memory	STX
Subtract Memory Byte from Accumulator	SUB

9.1.11 Read-Modify-Write Instructions

These instructions read a memory location or a register, modify its contents, and write the modified value back to the memory location or to the register. The test for negative or zero instruction (TST) is an exception to the read-modify-write sequence because it does not write a replacement value. **Table 9-2** lists the read-modify-write instructions.

Table 9-2. Read-Modify-Write Instructions

Instruction	Mnemonic
Arithmetic Shift Left	ASL
Arithmetic Shift Right	ASR
Clear Bit in Memory	BCLR
Set Bit in Memory	BSET
Clear	CLR
Complement (One's Complement)	COM
Decrement	DEC
Increment	INC
Logical Shift Left	LSL
Logical Shift Right	LSR
Negate (Two's Complement)	NEG
Rotate Left through Carry Bit	ROL
Rotate Right through Carry Bit	ROR
Test for Negative or Zero	TST

9.1.12 Jump/Branch Instructions

Jump instructions allow the CPU to interrupt the normal sequence of the program counter. The unconditional jump instruction (JMP) and the jump to subroutine instruction (JSR) have no register operand. Branch instructions allow the CPU to interrupt the normal sequence of the program counter when a test condition is met. If the test condition is not met, the branch is not performed. All branch instructions use relative addressing.

Bit test and branch instructions cause a branch based on the state of any readable bit in the first 256 memory locations. These three-byte instructions use a combination of direct addressing and relative addressing. The direct address of the byte to be tested is in the byte following the opcode. The third byte is the signed offset byte. The CPU finds the conditional branch destination by adding the

third byte to the program counter if the specified bit tests true. The bit to be tested and its condition (set or clear) is part of the opcode. The span of branching is from -128 to +127 from the address of the next location after the branch instruction. The CPU also transfers the tested bit to the carry/borrow bit of the condition code register. **Table 9-3** lists the jump and branch instructions.

Table 9-3. Jump and Branch Instructions

Instruction	Mnemonic
Branch if Carry Bit Clear	BCC
Branch if Carry Bit Set	BCS
Branch if Equal	BEQ
Branch if Half-Carry Bit Clear	BHCC
Branch if Half-Carry Bit Set	BHCS
Branch if Higher	BHI
Branch if Higher or Same	BHS
Branch if $\overline{\text{IRQ}}$ Pin High	BIH
Branch if $\overline{\text{IRQ}}$ Pin Low	BIL
Branch if Lower	BLO
Branch if Lower or Same	BLS
Branch if Interrupt Mask Clear	BMC
Branch if Minus	BMI
Branch if Interrupt Mask Set	BMS
Branch if Not Equal	BNE
Branch if Plus	BPL
Branch Always	BRA
Branch if Bit Clear	BRCLR
Branch Never	BRN
Branch if Bit Set	BRSET
Branch to Subroutine	BSR
Unconditional Jump	JMP
Jump to Subroutine	JSR

9.1.13 Bit Manipulation Instructions

The CPU can set or clear any writable bit in the first 256 bytes of memory. Port registers, port data direction registers, timer registers, and on-chip RAM locations are in the first 256 bytes of memory. The CPU can also test and branch based on the state of any bit in any of the first 256 memory locations. Bit manipulation instructions use direct addressing. **Table 9-4** lists these instructions.

Table 9-4. Bit Manipulation Instructions

Instruction	Mnemonic
Clear Bit	BCLR
Branch if Bit Clear	BRCLR
Branch if Bit Set	BRSET
Set Bit	BSET

9.1.14 Control Instructions

These register reference instructions control CPU operation during program execution. Control instructions, listed in **Table 9-5**, use inherent addressing.

Table 9-5. Control Instructions

Instruction	Mnemonic
Clear Carry Bit	CLC
Clear Interrupt Mask	CLI
No Operation	NOP
Reset Stack Pointer	RSP
Return from Interrupt	RTI
Return from Subroutine	RTS
Set Carry Bit	SEC
Set Interrupt Mask	SEI
Stop Oscillator and Enable \overline{IRQ} Pin	STOP
Software Interrupt	SWI
Transfer Accumulator to Index Register	TAX
Transfer Index Register to Accumulator	TXA
Stop CPU Clock and Enable Interrupts	WAIT

9.1.15 Instruction Set Summary

Table 9-6 is an alphabetical list of all M68HC05 instructions and shows the effect of each instruction on the condition code register.

Table 9-6. Instruction Set Summary

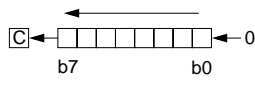
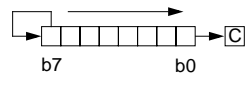
Source Form	Operation	Description	Effect on CCR					Address Mode	Opcode	Operand	Cycles
			H	I	N	Z	C				
ADC #opr ADC opr ADC opr ADC opr,X ADC opr,X ADC ,X	Add with Carry	$A \leftarrow (A) + (M) + (C)$	↑	—	↑	↑	↑	IMM DIR EXT IX2 IX1 IX	A9 B9 C9 D9 E9 F9	ii dd hh ll ee ff ff	2 3 4 5 4 3
ADD #opr ADD opr ADD opr ADD opr,X ADD opr,X ADD ,X	Add without Carry	$A \leftarrow (A) + (M)$	↑	—	↑	↑	↑	IMM DIR EXT IX2 IX1 IX	AB BB CB DB EB FB	ii dd hh ll ee ff ff	2 3 4 5 4 3
AND #opr AND opr AND opr AND opr,X AND opr,X AND ,X	Logical AND	$A \leftarrow (A) \wedge (M)$	—	—	↑	↑	—	IMM DIR EXT IX2 IX1 IX	A4 B4 C4 D4 E4 F4	ii dd hh ll ee ff ff	2 3 4 5 4 3
ASL opr ASLA ASLX ASL opr,X ASL ,X	Arithmetic Shift Left (Same as LSL)		—	—	↑	↑	↑	↑	38 48 58 68 78	dd ff	5 3 3 6 5
ASR opr ASRA ASRX ASR opr,X ASR ,X	Arithmetic Shift Right		—	—	↑	↑	↑	DIR INH INH IX1 IX	37 47 57 67 77	dd ff	5 3 3 6 5
BCC rel	Branch if Carry Bit Clear	$PC \leftarrow (PC) + 2 + rel ? C = 0$	—	—	—	—	—	REL	24	rr	3
BCLR n opr	Clear Bit n	$M_n \leftarrow 0$	—	—	—	—	—	DIR (b0) DIR (b1) DIR (b2) DIR (b3) DIR (b4) DIR (b5) DIR (b6) DIR (b7)	11 13 15 17 19 1B 1D 1F	dd dd dd dd dd dd dd dd	5 5 5 5 5 5 5 5
BCS rel	Branch if Carry Bit Set (Same as BLO)	$PC \leftarrow (PC) + 2 + rel ? C = 1$	—	—	—	—	—	REL	25	rr	3
BEQ rel	Branch if Equal	$PC \leftarrow (PC) + 2 + rel ? Z = 1$	—	—	—	—	—	REL	27	rr	3

Table 9-6. Instruction Set Summary (Continued)

Source Form	Operation	Description	Effect on CCR					Address Mode	Opcode	Operand	Cycles
			H	I	N	Z	C				
BHCC <i>rel</i>	Branch if Half-Carry Bit Clear	$PC \leftarrow (PC) + 2 + rel ? H = 0$	—	—	—	—	—	REL	28	rr	3
BHCS <i>rel</i>	Branch if Half-Carry Bit Set	$PC \leftarrow (PC) + 2 + rel ? H = 1$	—	—	—	—	—	REL	29	rr	3
BHI <i>rel</i>	Branch if Higher	$PC \leftarrow (PC) + 2 + rel ? C \vee Z = 0$	—	—	—	—	—	REL	22	rr	3
BHS <i>rel</i>	Branch if Higher or Same	$PC \leftarrow (PC) + 2 + rel ? C = 0$	—	—	—	—	—	REL	24	rr	3
BIH <i>rel</i>	Branch if \overline{IRQ} Pin High	$PC \leftarrow (PC) + 2 + rel ? \overline{IRQ} = 1$	—	—	—	—	—	REL	2F	rr	3
BIL <i>rel</i>	Branch if \overline{IRQ} Pin Low	$PC \leftarrow (PC) + 2 + rel ? \overline{IRQ} = 0$	—	—	—	—	—	REL	2E	rr	3
BIT # <i>opr</i> BIT <i>opr</i> BIT <i>opr</i> ,X BIT <i>opr</i> ,X BIT ,X	Bit Test Accumulator with Memory Byte	(A) \wedge (M)	—	—	↑	↓	—	IMM DIR EXT IX2 IX1 IX	A5 B5 C5 D5 E5 F5	ii dd hh ll ee ff ff p	2 3 4 5 4 3
BLO <i>rel</i>	Branch if Lower (Same as BCS)	$PC \leftarrow (PC) + 2 + rel ? C = 1$	—	—	—	—	—	REL	25	rr	3
BLS <i>rel</i>	Branch if Lower or Same	$PC \leftarrow (PC) + 2 + rel ? C \vee Z = 1$	—	—	—	—	—	REL	23	rr	3
BMC <i>rel</i>	Branch if Interrupt Mask Clear	$PC \leftarrow (PC) + 2 + rel ? I = 0$	—	—	—	—	—	REL	2C	rr	3
BMI <i>rel</i>	Branch if Minus	$PC \leftarrow (PC) + 2 + rel ? N = 1$	—	—	—	—	—	REL	2B	rr	3
BMS <i>rel</i>	Branch if Interrupt Mask Set	$PC \leftarrow (PC) + 2 + rel ? I = 1$	—	—	—	—	—	REL	2D	rr	3
BNE <i>rel</i>	Branch if Not Equal	$PC \leftarrow (PC) + 2 + rel ? Z = 0$	—	—	—	—	—	REL	26	rr	3
BPL <i>rel</i>	Branch if Plus	$PC \leftarrow (PC) + 2 + rel ? N = 0$	—	—	—	—	—	REL	2A	rr	3
BRA <i>rel</i>	Branch Always	$PC \leftarrow (PC) + 2 + rel ? 1 = 1$	—	—	—	—	—	REL	20	rr	3
BRCLR <i>n opr rel</i>	Branch if bit n clear	$PC \leftarrow (PC) + 2 + rel ? Mn = 0$	—	—	—	—	↑	DIR (b0)	01	dd rr	5
								DIR (b1)	03	dd rr	5
								DIR (b2)	05	dd rr	5
								DIR (b3)	07	dd rr	5
								DIR (b4)	09	dd rr	5
								DIR (b5)	0B	dd rr	5
								DIR (b6)	0D	dd rr	5
								DIR (b7)	0F	dd rr	5
BRSET <i>n opr rel</i>	Branch if Bit n Set	$PC \leftarrow (PC) + 2 + rel ? Mn = 1$	—	—	—	—	↓	DIR (b0)	00	dd rr	5
								DIR (b1)	02	dd rr	5
								DIR (b2)	04	dd rr	5
								DIR (b3)	06	dd rr	5
								DIR (b4)	08	dd rr	5
								DIR (b5)	0A	dd rr	5
								DIR (b6)	0C	dd rr	5
								DIR (b7)	0E	dd rr	5
BRN <i>rel</i>	Branch Never	$PC \leftarrow (PC) + 2 + rel ? 1 = 0$	—	—	—	—	—	REL	21	rr	3

Table 9-6. Instruction Set Summary (Continued)

Source Form	Operation	Description	Effect on CCR					Address Mode	Opcode	Operand	Cycles
			H	I	N	Z	C				
BSET <i>n opr</i>	Set Bit <i>n</i>	$M_n \leftarrow 1$						DIR (b0)	10	dd	5
								DIR (b1)	12	dd	5
								DIR (b2)	14	dd	5
								DIR (b3)	16	dd	5
								DIR (b4)	18	dd	5
								DIR (b5)	1A	dd	5
								DIR (b6)	1C	dd	5
					DIR (b7)	1E	dd	5			
BSR <i>rel</i>	Branch to Subroutine	$PC \leftarrow (PC) + 2$; push (PCL) $SP \leftarrow (SP) - 1$; push (PCH) $SP \leftarrow (SP) - 1$ $PC \leftarrow (PC) + rel$	—	—	—	—	—	REL	AD	rr	6
CLC	Clear Carry Bit	$C \leftarrow 0$	—	—	—	—	0	INH	98		2
CLI	Clear Interrupt Mask	$I \leftarrow 0$	—	0	—	—	—	INH	9A		2
CLR <i>opr</i> CLRA CLR <i>X</i> CLR <i>opr,X</i> CLR <i>,X</i>	Clear Byte	$M \leftarrow \$00$						DIR	3F	dd	5
$A \leftarrow \$00$							INH	4F		3	
$X \leftarrow \$00$		—	—	0	1	—	INH	5F		3	
$M \leftarrow \$00$							IX1	6F	ff	6	
$M \leftarrow \$00$							IX	7F		5	
CMP # <i>opr</i> CMP <i>opr</i> CMP <i>opr</i> CMP <i>opr,X</i> CMP <i>opr,X</i> CMP <i>,X</i>	Compare Accumulator with Memory Byte	$(A) - (M)$						IMM	A1	ii	2
							DIR	B1	dd	3	
							EXT	C1	hh ll	4	
							IX2	D1	ee ff	5	
							IX1	E1	ff	4	
							IX	F1		3	
COM <i>opr</i> COMA COM <i>X</i> COM <i>opr,X</i> COM <i>,X</i>	Complement Byte (One's Complement)	$M \leftarrow (\overline{M}) = \$FF - (M)$						DIR	33	dd	5
$A \leftarrow (\overline{A}) = \$FF - (M)$							INH	43		3	
$X \leftarrow (\overline{X}) = \$FF - (M)$		—	—	↑	↑	1	INH	53		3	
$M \leftarrow (\overline{M}) = \$FF - (M)$							IX1	63	ff	6	
$M \leftarrow (\overline{M}) = \$FF - (M)$							IX	73		5	
CPX # <i>opr</i> CPX <i>opr</i> CPX <i>opr</i> CPX <i>opr,X</i> CPX <i>opr,X</i> CPX <i>,X</i>	Compare Index Register with Memory Byte	$(X) - (M)$						IMM	A3	ii	2
							DIR	B3	dd	3	
							EXT	C3	hh ll	4	
							IX2	D3	ee ff	5	
							IX1	E3	ff	4	
							IX	F3		3	
DEC <i>opr</i> DECA DEC <i>X</i> DEC <i>opr,X</i> DEC <i>,X</i>	Decrement Byte	$M \leftarrow (M) - 1$						DIR	3A	dd	5
$A \leftarrow (A) - 1$							INH	4A		3	
$X \leftarrow (X) - 1$		—	—	↑	↑	—	INH	5A		3	
$M \leftarrow (M) - 1$							IX1	6A	ff	6	
$M \leftarrow (M) - 1$							IX	7A		5	
EOR # <i>opr</i> EOR <i>opr</i> EOR <i>opr</i> EOR <i>opr,X</i> EOR <i>opr,X</i> EOR <i>,X</i>	EXCLUSIVE OR Accumulator with Memory Byte	$A \leftarrow (A) \oplus (M)$						IMM	A8	ii	2
							DIR	B8	dd	3	
							EXT	C8	hh ll	4	
							IX2	D8	ee ff	5	
							IX1	E8	ff	4	
							IX	F8		3	

Table 9-6. Instruction Set Summary (Continued)

Source Form	Operation	Description	Effect on CCR					Address Mode	Opcode	Operand	Cycles	
			H	I	N	Z	C					
INC <i>opr</i> INCA INCX INC <i>opr</i> ,X INC ,X	Increment Byte	$M \leftarrow (M) + 1$						DIR	3C	dd	5	
		$A \leftarrow (A) + 1$						INH	4C		3	
		$X \leftarrow (X) + 1$			↑	↑	—	INH	5C		3	
		$M \leftarrow (M) + 1$						IX1	6C	ff	6	
		$M \leftarrow (M) + 1$						IX	7C		5	
JMP <i>opr</i> JMP <i>opr</i> JMP <i>opr</i> ,X JMP <i>opr</i> ,X JMP ,X	Unconditional Jump	$PC \leftarrow \text{Jump Address}$						DIR	BC	dd	2	
								EXT	CC	hh ll	3	
								IX2	DC	ee ff	4	
								IX1	EC	ff	3	
								IX	FC		2	
JSR <i>opr</i> JSR <i>opr</i> JSR <i>opr</i> ,X JSR <i>opr</i> ,X JSR ,X	Jump to Subroutine	$PC \leftarrow (PC) + n$ ($n = 1, 2, \text{ or } 3$)						DIR	BD	dd	5	
		Push (PCL); $SP \leftarrow (SP) - 1$						EXT	CD	hh ll	6	
		Push (PCH); $SP \leftarrow (SP) - 1$						IX2	DD	ee ff	7	
		Push (PCH); $SP \leftarrow (SP) - 1$						IX1	ED	ff	6	
		$PC \leftarrow \text{Conditional Address}$						IX	FD		5	
LDA # <i>opr</i> LDA <i>opr</i> LDA <i>opr</i> LDA <i>opr</i> ,X LDA <i>opr</i> ,X LDA ,X	Load Accumulator with Memory Byte	$A \leftarrow (M)$						IMM	A6	ii	2	
								DIR	B6	dd	3	
						↑	↑	—	EXT	C6	hh ll	4
									IX2	D6	ee ff	5
									IX1	E6	ff	4
									IX	F6		3
LDX # <i>opr</i> LDX <i>opr</i> LDX <i>opr</i> LDX <i>opr</i> ,X LDX <i>opr</i> ,X LDX ,X	Load Index Register with Memory Byte	$X \leftarrow (M)$						IMM	AE	ii	2	
								DIR	BE	dd	3	
						↑	↑	—	EXT	CE	hh ll	4
									IX2	DE	ee ff	5
									IX1	EE	ff	4
									IX	FE		3
LSL <i>opr</i> LSLA LSLX LSL <i>opr</i> ,X LSL ,X	Logical Shift Left (Same as ASL)							DIR	38	dd	5	
									INH	48		3
						↑	↑	↑	INH	58		3
									IX1	68	ff	6
									IX	78		5
LSR <i>opr</i> LSRA LSRX LSR <i>opr</i> ,X LSR ,X	Logical Shift Right							DIR	34	dd	5	
									INH	44		3
						0	↑	↑	INH	54		3
									IX1	64	ff	6
									IX	74		5
MUL	Unsigned Multiply	$X : A \leftarrow (X) \times (A)$	0	—	—	—	0	INH	42		11	
NEG <i>opr</i> NEGA NEGX NEG <i>opr</i> ,X NEG ,X	Negate Byte (Two's Complement)	$M \leftarrow -(M) = \$00 - (M)$						DIR	30	ii	5	
		$A \leftarrow -(A) = \$00 - (A)$						INH	40		3	
		$X \leftarrow -(X) = \$00 - (X)$			↑	↑	↑	INH	50		3	
		$M \leftarrow -(M) = \$00 - (M)$						IX1	60	ff	6	
		$M \leftarrow -(M) = \$00 - (M)$						IX	70		5	
NOP	No Operation		—	—	—	—	—	INH	9D		2	

Table 9-6. Instruction Set Summary (Continued)

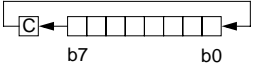
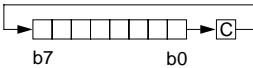
Source Form	Operation	Description	Effect on CCR					Address Mode	Opcode	Operand	Cycles
			H	I	N	Z	C				
ORA #opr ORA opr ORA opr ORA opr,X ORA opr,X ORA ,X	Logical OR Accumulator with Memory	$A \leftarrow (A) \vee (M)$	—	—	↕	↕	—	IMM DIR EXT IX2 IX1 IX	AA BA CA DA EA FA	ii dd hh ll ee ff ff	2 3 4 5 4 3
ROL opr ROLA ROLX ROL opr,X ROL ,X	Rotate Byte Left through Carry Bit		—	—	↕	↕	↕	DIR INH INH IX1 IX	39 49 59 69 79	dd ff	5 3 3 6 5
ROR opr RORA RORX ROR opr,X ROR ,X	Rotate Byte Right through Carry Bit		—	—	↕	↕	↕	DIR INH INH IX1 IX	36 46 56 66 76	dd ff	5 3 3 6 5
RSP	Reset Stack Pointer	$SP \leftarrow \$00FF$	—	—	—	—	—	INH	9C		2
RTI	Return from Interrupt	$SP \leftarrow (SP) + 1$; Pull (CCR) $SP \leftarrow (SP) + 1$; Pull (A) $SP \leftarrow (SP) + 1$; Pull (X) $SP \leftarrow (SP) + 1$; Pull (PCH) $SP \leftarrow (SP) + 1$; Pull (PCL)	↕	↕	↕	↕	↕	INH	80		9
RTS	Return from Subroutine	$SP \leftarrow (SP) + 1$; Pull (PCH) $SP \leftarrow (SP) + 1$; Pull (PCL)	—	—	—	—	—	INH	81		6
SBC #opr SBC opr SBC opr SBC opr,X SBC opr,X SBC ,X	Subtract Memory Byte and Carry Bit from Accumulator	$A \leftarrow (A) - (M) - (C)$	—	—	↕	↕	↕	IMM DIR EXT IX2 IX1 IX	A2 B2 C2 D2 E2 F2	ii dd hh ll ee ff ff	2 3 4 5 4 3
SEC	Set Carry Bit	$C \leftarrow 1$	—	—	—	—	1	INH	99		2
SEI	Set Interrupt Mask	$I \leftarrow 1$	—	1	—	—	—	INH	9B		2
STA opr STA opr STA opr,X STA opr,X STA ,X	Store Accumulator in Memory	$M \leftarrow (A)$	—	—	↕	↕	—	DIR EXT IX2 IX1 IX	B7 C7 D7 E7 F7	dd hh ll ee ff ff	4 5 6 5 4
STOP	Stop Oscillator and Enable $\bar{I}RQ$ Pin		—	0	—	—	—	INH	8E		2
STX opr STX opr STX opr,X STX opr,X STX ,X	Store Index Register In Memory	$M \leftarrow (X)$	—	—	↕	↕	—	DIR EXT IX2 IX1 IX	BF CF DF EF FF	dd hh ll ee ff ff	4 5 6 5 4

Table 9-6. Instruction Set Summary (Continued)

Source Form	Operation	Description	Effect on CCR					Address Mode	Opcode	Operand	Cycles
			H	I	N	Z	C				
SUB # <i>opr</i> SUB <i>opr</i> SUB <i>opr</i> SUB <i>opr</i> , <i>X</i> SUB <i>opr</i> , <i>X</i> SUB , <i>X</i>	Subtract Memory Byte from Accumulator	$A \leftarrow (A) - (M)$	—	—	↓	↓	↓	IMM DIR EXT IX2 IX1 IX	A0 B0 C0 D0 E0 F0	ii dd hh ll ee ff ff	2 3 4 5 4 3
SWI	Software Interrupt	$PC \leftarrow (PC) + 1$; Push (PCL) $SP \leftarrow (SP) - 1$; Push (PCH) $SP \leftarrow (SP) - 1$; Push (X) $SP \leftarrow (SP) - 1$; Push (A) $SP \leftarrow (SP) - 1$; Push (CCR) $SP \leftarrow (SP) - 1$; $I \leftarrow 1$ PCH ← Interrupt Vector High Byte PCL ← Interrupt Vector Low Byte	—	1	—	—	—	INH	83		10
TAX	Transfer Accumulator to Index Register	$X \leftarrow (A)$	—	—	—	—	—	INH	97		2
TST <i>opr</i> TSTA TSTX TST <i>opr</i> , <i>X</i> TST , <i>X</i>	Test Memory Byte for Negative or Zero	$(M) - \$00$	—	—	↓	↓	—	DIR INH INH IX1 IX	3D 4D 5D 6D 7D	dd ff	4 3 3 5 4
TXA	Transfer Index Register to Accumulator	$A \leftarrow (X)$	—	—	—	—	—	INH	9F		2
WAIT	Stop CPU Clock and Enable Interrupts		—	0	—	—	—	INH	8F		2

A	Accumulator	<i>opr</i>	Operand (one or two bytes)
C	Carry/borrow flag	PC	Program counter
CCR	Condition code register	PCH	Program counter high byte
dd	Direct address of operand	PCL	Program counter low byte
dd rr	Direct address of operand and relative offset of branch instruction	REL	Relative addressing mode
DIR	Direct addressing mode	<i>rel</i>	Relative program counter offset byte
ee ff	High and low bytes of offset in indexed, 16-bit offset addressing	rr	Relative program counter offset byte
EXT	Extended addressing mode	SP	Stack pointer
ff	Offset byte in indexed, 8-bit offset addressing	X	Index register
H	Half-carry flag	Z	Zero flag
hh ll	High and low bytes of operand address in extended addressing	#	Immediate value
I	Interrupt mask	^	Logical AND
ii	Immediate operand byte	∨	Logical OR
IMM	Immediate addressing mode	⊕	Logical EXCLUSIVE OR
INH	Inherent addressing mode	()	Contents of
IX	Indexed, no offset addressing mode	-()	Negation (two's complement)
IX1	Indexed, 8-bit offset addressing mode	←	Loaded with
IX2	Indexed, 16-bit offset addressing mode	?	If
M	Memory location	:	Concatenated with
N	Negative flag	↓	Set or cleared
<i>n</i>	Any bit	—	Not affected



MO
9-14



Table 9-7. Opcode Map

INSTRUCTION SET

MC68HC05LJ5
REV 1

		Bit Manipulation		Branch	Read-Modify-Write				Control		Register/Memory								
		DIR	DIR	REL	DIR	INH	INH	IX1	IX	INH	INH	IMM	DIR	EXT	IX2	IX1	IX		
MSB	LSB	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F	MSB	LSB
	0	BRSET0 ⁵ ₃ DIR	BSET0 ⁵ ₂ DIR	BRA ³ _{REL}	NEG ⁵ _{DIR}	NEGA ³ _{INH}	NEGX ³ _{INH}	NEG ⁶ _{IX1}	NEG ⁵ _{IX}	RTI ⁹ _{INH}		SUB ² _{IMM}	SUB ³ _{DIR}	SUB ⁴ _{EXT}	SUB ⁵ _{IX2}	SUB ⁴ _{IX1}	SUB ³ _{IX}		0
	1	BRCLR0 ⁵ ₃ DIR	BCLR0 ⁵ _{DIR}	BRN ³ _{REL}						RTS ⁶ _{INH}		CMP ² _{IMM}	CMP ³ _{DIR}	CMP ⁴ _{EXT}	CMP ⁵ _{IX2}	CMP ⁴ _{IX1}	CMP ³ _{IX}		1
	2	BRSET1 ⁵ ₃ DIR	BSET1 ⁵ _{DIR}	BHI ³ _{REL}		MUL ¹¹ _{INH}						SBC ² _{IMM}	SBC ³ _{DIR}	SBC ⁴ _{EXT}	SBC ⁵ _{IX2}	SBC ⁴ _{IX1}	SBC ³ _{IX}		2
	3	BRCLR1 ⁵ ₃ DIR	BCLR1 ⁵ _{DIR}	BLS ³ _{REL}	COM ⁵ _{DIR}	COMA ³ _{INH}	COMX ³ _{INH}	COM ⁶ _{IX1}	COM ⁵ _{IX}	SWI ¹⁰ _{INH}		CPX ² _{IMM}	CPX ³ _{DIR}	CPX ⁴ _{EXT}	CPX ⁵ _{IX2}	CPX ⁴ _{IX1}	CPX ³ _{IX}		3
	4	BRSET2 ⁵ ₃ DIR	BSET2 ⁵ _{DIR}	BCC ³ _{REL}	LSR ⁵ _{DIR}	LSRA ³ _{INH}	LSRX ³ _{INH}	LSR ⁶ _{IX1}	LSR ⁵ _{IX}			AND ² _{IMM}	AND ³ _{DIR}	AND ⁴ _{EXT}	AND ⁵ _{IX2}	AND ⁴ _{IX1}	AND ³ _{IX}		4
	5	BRCLR2 ⁵ ₃ DIR	BCLR2 ⁵ _{DIR}	BCS/BLO ³ _{REL}								BIT ² _{IMM}	BIT ³ _{DIR}	BIT ⁴ _{EXT}	BIT ⁵ _{IX2}	BIT ⁴ _{IX1}	BIT ³ _{IX}		5
	6	BRSET3 ⁵ ₃ DIR	BSET3 ⁵ _{DIR}	BNE ³ _{REL}	ROR ⁵ _{DIR}	RORA ³ _{INH}	RORX ³ _{INH}	ROR ⁶ _{IX1}	ROR ⁵ _{IX}			LDA ² _{IMM}	LDA ³ _{DIR}	LDA ⁴ _{EXT}	LDA ⁵ _{IX2}	LDA ⁴ _{IX1}	LDA ³ _{IX}		6
	7	BRCLR3 ⁵ ₃ DIR	BCLR3 ⁵ _{DIR}	BEQ ³ _{REL}	ASR ⁵ _{DIR}	ASRA ³ _{INH}	ASRX ³ _{INH}	ASR ⁶ _{IX1}	ASR ⁵ _{IX}		TAX ² _{INH}		STA ⁴ _{DIR}	STA ⁵ _{EXT}	STA ⁶ _{IX2}	STA ⁵ _{IX1}	STA ⁴ _{IX}		7
	8	BRSET4 ⁵ ₃ DIR	BSET4 ⁵ _{DIR}	BHCC ³ _{REL}	ASL/LSL ⁵ _{DIR}	ASLA/LSLA ³ _{INH}	ASLX/LSLX ³ _{INH}	ASL/LSL ⁶ _{IX1}	ASL/LSL ⁵ _{IX}		CLC ² _{INH}	EOR ² _{IMM}	EOR ³ _{DIR}	EOR ⁴ _{EXT}	EOR ⁵ _{IX2}	EOR ⁴ _{IX1}	EOR ³ _{IX}		8
	9	BRCLR4 ⁵ ₃ DIR	BCLR4 ⁵ _{DIR}	BHCS ³ _{REL}	ROL ⁵ _{DIR}	ROLA ³ _{INH}	ROLX ³ _{INH}	ROL ⁶ _{IX1}	ROL ⁵ _{IX}		SEC ² _{INH}	ADC ² _{IMM}	ADC ³ _{DIR}	ADC ⁴ _{EXT}	ADC ⁵ _{IX2}	ADC ⁴ _{IX1}	ADC ³ _{IX}		9
	A	BRSET5 ⁵ ₃ DIR	BSET5 ⁵ _{DIR}	BPL ³ _{REL}	DEC ⁵ _{DIR}	DECA ³ _{INH}	DECX ³ _{INH}	DEC ⁶ _{IX1}	DEC ⁵ _{IX}		CLI ² _{INH}	ORA ² _{IMM}	ORA ³ _{DIR}	ORA ⁴ _{EXT}	ORA ⁵ _{IX2}	ORA ⁴ _{IX1}	ORA ³ _{IX}		A
	B	BRCLR5 ⁵ ₃ DIR	BCLR5 ⁵ _{DIR}	BMI ³ _{REL}							SEI ² _{INH}	ADD ² _{IMM}	ADD ³ _{DIR}	ADD ⁴ _{EXT}	ADD ⁵ _{IX2}	ADD ⁴ _{IX1}	ADD ³ _{IX}		B
	C	BRSET6 ⁵ ₃ DIR	BSET6 ⁵ _{DIR}	BMC ³ _{REL}	INC ⁵ _{DIR}	INCA ³ _{INH}	INCX ³ _{INH}	INC ⁶ _{IX1}	INC ⁵ _{IX}		RSP ² _{INH}		JMP ² _{DIR}	JMP ³ _{EXT}	JMP ⁴ _{IX2}	JMP ³ _{IX1}	JMP ² _{IX}		C
	D	BRCLR6 ⁵ ₃ DIR	BCLR6 ⁵ _{DIR}	BMS ³ _{REL}	TST ⁴ _{DIR}	TSTA ³ _{INH}	TSTX ³ _{INH}	TST ⁵ _{IX1}	TST ⁴ _{IX}		NOP ² _{INH}	BSR ⁶ _{REL}	JSR ⁵ _{DIR}	JSR ⁶ _{EXT}	JSR ⁷ _{IX2}	JSR ⁶ _{IX1}	JSR ⁵ _{IX}		D
	E	BRSET7 ⁵ ₃ DIR	BSET7 ⁵ _{DIR}	BIL ³ _{REL}						STOP ² _{INH}		LDX ² _{IMM}	LDX ³ _{DIR}	LDX ⁴ _{EXT}	LDX ⁵ _{IX2}	LDX ⁴ _{IX1}	LDX ³ _{IX}		E
	F	BRCLR7 ⁵ ₃ DIR	BCLR7 ⁵ _{DIR}	BIH ³ _{REL}	CLR ⁵ _{DIR}	CLRA ³ _{INH}	CLR ³ _{INH}	CLR ⁶ _{IX1}	CLR ⁵ _{IX}	WAIT ² _{INH}	TXA ² _{INH}		STX ⁴ _{DIR}	STX ⁵ _{EXT}	STX ⁶ _{IX2}	STX ⁵ _{IX1}	STX ⁴ _{IX}		F

INH = Inherent
IMM = Immediate
DIR = Direct
EXT = Extended

REL = Relative
IX = Indexed, No Offset
IX1 = Indexed, 8-Bit Offset
IX2 = Indexed, 16-Bit Offset

LSB of Opcode in Hexadecimal

MSB	0	MSB of Opcode in Hexadecimal
LSB	BRSET0 ⁵ ₃ DIR	Number of Cycles Opcode Mnemonic Number of Bytes/Addressing Mode

SECTION 10 ELECTRICAL SPECIFICATIONS

This section provides the electrical and timing specifications for the MC68HC05LJ5.

10.1 MAXIMUM RATINGS

(Voltages referenced to V_{SS})

Rating	Symbol	Value	Unit
Supply Voltage	V_{DD}	-0.3 to +7.0	V
Test Mode (\overline{IRQ} Pin Only)	V_{IN}	$V_{SS} - 0.3$ to $2V_{DD} + 0.3$	V
Current Drain Per Pin Excluding PB1, PB2, V_{DD} and V_{SS}	I	25	mA
Operating Junction Temperature	T_J	+150	°C
Operating Temperature Range MC68HC05LJ5 (Standard) MC68HC05LJ5 (Extended)	T_A T_A	T_L to T_H 0 to +70 -40 to +85	°C °C
Storage Temperature Range	T_{stg}	-65 to +150	°C

NOTE

Maximum ratings are the extreme limits the device can be exposed to without causing permanent damage to the chip. The device is **not** intended to operate at these conditions.

The MCU contains circuitry that protect the inputs against damage from high static voltages; however, do not apply voltages higher than those shown in the table below. Keep V_{IN} and V_{OUT} within the range from $V_{SS} \leq (V_{IN} \text{ or } V_{OUT}) \leq V_{DD}$. Connect unused inputs to the appropriate voltage level, either V_{SS} or V_{DD} .

10.2 THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance PDIP	θ_{JA}	60	°C/W
SOIC	θ_{JA}	60	°C/W

10.3 DC ELECTRICAL CHARACTERISTICS

Table 10-1. DC Electrical Characteristics

($V_{DD} = 5.0\text{Vdc} \pm 10\%$, $V_{SS} = 0\text{Vdc}$, $T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$, unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
Output Voltage $I_{Load} = 10.0\ \mu\text{A}$	V_{OL} V_{OH}	— $V_{DD} - 0.1$	— —	0.1 —	V
Output High Voltage ($I_{Load} = -0.8\ \text{mA}$) PA0-5, PB0, PB3-5	V_{OH}	$V_{DD} - 0.8$	—	—	V
Output Low Voltage ($I_{Load} = 1.6\ \text{mA}$) PA0-3, PB0, PB3-5 ($I_{Load} = 8\ \text{mA}$) PA4-7 ($I_{Load} = 25\ \text{mA}$) PB1, PB2 (see note 8)	V_{OL}	— — —	— — —	0.4 0.4 0.5	V
Input High Voltage PA0-5, PB0-5, $\overline{\text{IRQ}}$, $\overline{\text{RESET}}$, OSC1	V_{IH}	$0.7 \times V_{DD}$	—	V_{DD}	V
Input Low Voltage PA0-5, PB0-5, $\overline{\text{IRQ}}$, $\overline{\text{RESET}}$, OSC1	V_{IL}	V_{SS}	—	$0.2 \times V_{DD}$	V
Positive-Going Input Threshold Voltage PA6, PA7	V_{T+}	—	1.7	—	V
Negative-Going Input Threshold Voltage PA6, PA7	V_{T-}	—	1.15	—	V
Supply Current (see Notes) Run Wait Stop (LVR on) 25°C -40°C to +85°C Stop (LVR off) 25°C -40°C to +85°C	I_{DD}	— — — — — —	5.5 2 160 — <i>TBD</i> —	8 4 300 — <i>TBD</i> —	mA mA μA μA μA μA
I/O Ports Hi-Z Leakage Current PA0-7, PB0-5 (without individual pull-down/up activated)	I_Z	—	—	± 10	μA
Input Pull-down Current PA0-5, PB0, PB3-5 (with individual pull-down activated)	I_{IL}	50	100	200	μA
Input Current $\overline{\text{RESET}}$, $\overline{\text{IRQ}}$, OSC1	I_{in}	—	—	± 1	μA

Table 10-1. DC Electrical Characteristics

 ($V_{DD} = 5.0\text{Vdc} \pm 10\%$, $V_{SS} = 0\text{Vdc}$, $T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$, unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
Capacitance Ports (as Input or Output) RESET, IRQ, OSC1, OSC2/R	C_{out} C_{in}	— —	— —	12 8	pF pF
Crystal/Ceramic Resonator Oscillator Mode Internal Resistor OSC1 to OSC2/R	R_{OSC}	2	3	4	$M\Omega$
Pull-up Resistor PA6, PA7 (see note 10) PB1, PB2	R_{PULLUP}	2 15	5 30	10 60	$K\Omega$ $K\Omega$
LVR Trigger Voltage	V_{LVRI}	2.52	2.8	—	V

NOTES:

1. All values shown reflect average measurements.
2. Typical values at midpoint of voltage range, 25°C only.
3. Wait I_{DD} : Only MFT active.
4. Run (Operating) I_{DD} , Wait I_{DD} : Measured using external square wave clock source to OSC1 ($f_{OSC} = 2.0\text{MHz}$), all inputs 0.2 Vdc from rail; no DC loads, less than 50pF on all outputs, $C_L = 20\text{pF}$ on OSC2/R.
5. Wait, Stop I_{DD} : All ports configured as inputs, $V_{IL} = 0.2\text{Vdc}$, $V_{IH} = V_{DD} - 0.2\text{Vdc}$.
6. Stop I_{DD} measured with OSC1 = V_{SS} .
7. Wait I_{DD} is affected linearly by the OSC2/R capacitance.
8. $T_A = 0^\circ\text{C}$ to $+40^\circ\text{C}$.
9. Input voltage level on PA6 or PA7 higher than 2.4V is guaranteed to be recognized as logical one and as logic zero if lower than 0.8V.
10. PA6 and PA7 pull-up resistor values are specified under the condition that pin voltage ranges from 0V to 2.4V.

10.4 CONTROL TIMING

Table 10-2. Control Timing

($V_{DD} = 5.0V_{dc} \pm 10\%$, $V_{SS} = 0 V_{dc}$, $T_A = 0^\circ C$ to $+70^\circ C$, unless otherwise noted)

Characteristic	Symbol	Min	Max	Units
Frequency of Operation				
RC Oscillator Option (see note 3)	f_{OSC}	3.8	4.2	MHz
Crystal Oscillator Option	f_{OSC}	—	4.2	MHz
External Clock Source	f_{OSC}	DC	4.2	MHz
Internal Operating Frequency				
RC Oscillator ($f_{OSC} \div 2$)	f_{OP}	1.9	2.1	MHz
Crystal Oscillator ($f_{OSC} \div 2$)	f_{OP}	—	2.1	MHz
External Clock ($f_{OSC} \div 2$)	f_{OP}	DC	2.1	MHz
Cycle Time ($1 \div f_{OP}$)	t_{CYC}	475	—	ns
RESET Pulse Width Low	t_{RL}	1.5	—	t_{CYC}
IRQ Interrupt Pulse Width Low (Edge-Triggered)	t_{ILIH}	0.5	—	t_{CYC}
IRQ Interrupt Pulse Period	t_{ILIL}	see note 1	—	t_{CYC}
PA0 to PA3 Interrupt Pulse Width High (Edge-Triggered)	t_{IHIL}	0.5	—	t_{CYC}
PA0 to PA3 Interrupt Pulse Period	t_{IHHH}	see note 1	—	t_{CYC}
PA7 Interrupt Pulse Width Low	t_{LIH}	0.5	—	t_{CYC}
OSC1 Pulse Width	t_{OH}, t_{OL}	200	—	ns
Output High to Low Transition Period PA6, PA7, PB1	t_{SLOW}	0.5 (typical)		t_{CYC}

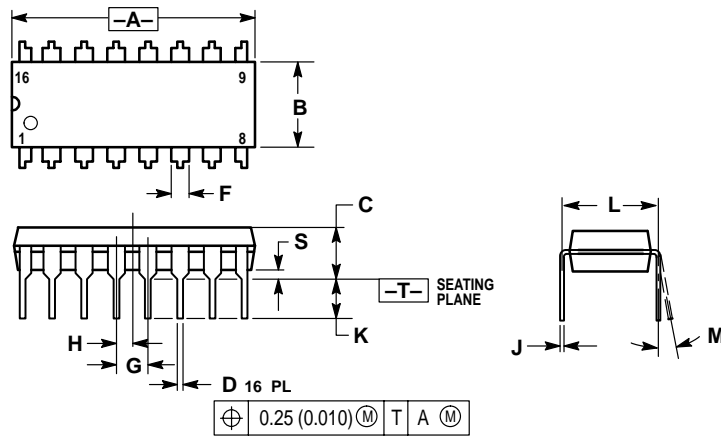
NOTES:

1. The minimum period t_{ILIL} or t_{IHHH} should not be less than the number of cycles it takes to execute the interrupt service routine plus $19 t_{CYC}$.
2. Effects of processing, temperature, and supply voltage (excluding tolerances of external R and C)
3. RC Oscillator: Typical center frequency is 4MHz. For the specified range of the operating center frequency from 3.8MHz (min.) to 4.2MHz (max.), the frequency tolerance is guaranteed to be more than $\pm 15\%$ under the conditions that $V_{DD} = 5V_{dc} \pm 10\%$, $T_A = 0^\circ C$ to $+40^\circ C$ and the tolerance of the external R is at most $\pm 1\%$.

SECTION 11 MECHANICAL SPECIFICATIONS

This section provides the mechanical dimensions for the three available packages for MC68HC05LJ5.

11.1 16-PIN PDIP (CASE #648)



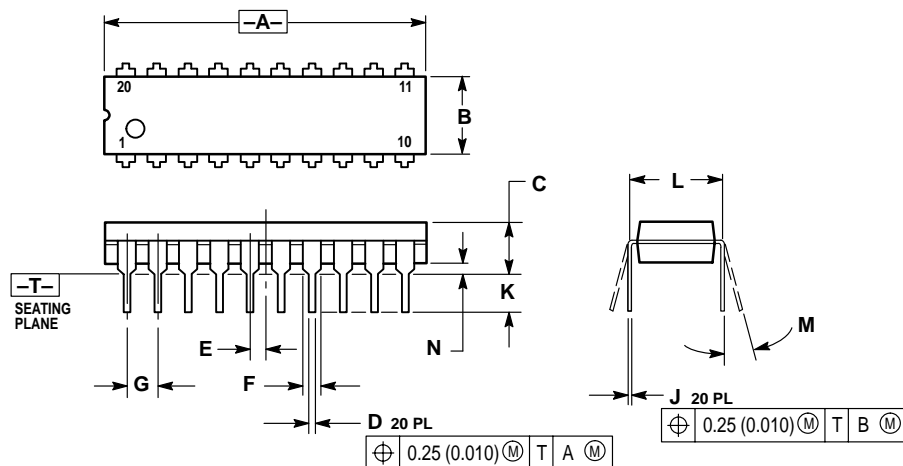
- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

- STYLE 1:
- PIN 1. CATHODE
 - 2. CATHODE
 - 3. CATHODE
 - 4. CATHODE
 - 5. CATHODE
 - 6. CATHODE
 - 7. CATHODE
 - 8. CATHODE
 - 9. ANODE
 - 10. ANODE
 - 11. ANODE
 - 12. ANODE
 - 13. ANODE
 - 14. ANODE
 - 15. ANODE
 - 16. ANODE

- STYLE 2:
- PIN 1. COMMON DRAIN
 - 2. COMMON DRAIN
 - 3. COMMON DRAIN
 - 4. COMMON DRAIN
 - 5. COMMON DRAIN
 - 6. COMMON DRAIN
 - 7. COMMON DRAIN
 - 8. COMMON DRAIN
 - 9. GATE
 - 10. SOURCE
 - 11. GATE
 - 12. SOURCE
 - 13. GATE
 - 14. SOURCE
 - 15. GATE
 - 16. SOURCE

Figure 11-1. 16-Pin PDIP Mechanical Dimensions

11.2 20-PIN PDIP (CASE #738)

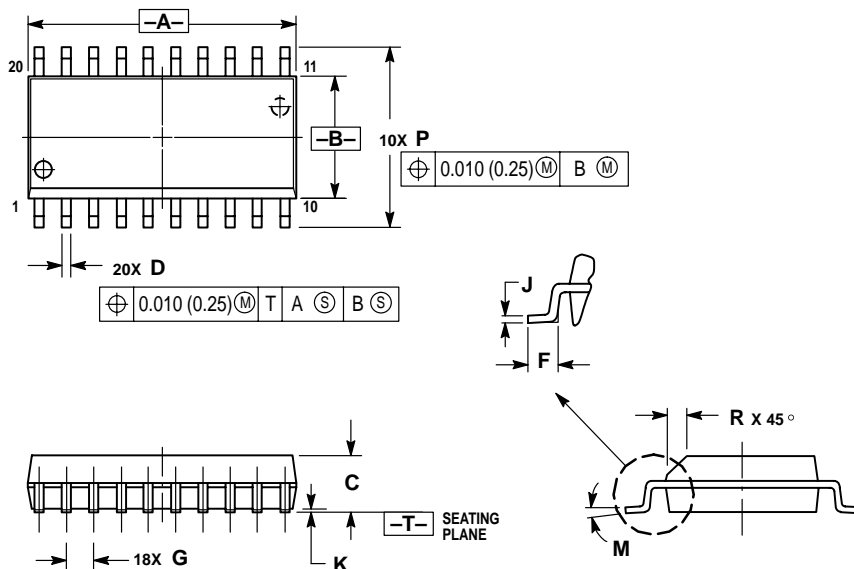


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.010	1.070	25.66	27.17
B	0.240	0.260	6.10	6.60
C	0.150	0.180	3.81	4.57
D	0.015	0.022	0.39	0.55
E	0.050 BSC		1.27 BSC	
F	0.050	0.070	1.27	1.77
G	0.100 BSC		2.54 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.140	2.80	3.55
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

Figure 11-2. 20-Pin PDIP Mechanical Dimensions


11.3 20-PIN SOIC (CASE #751D)



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
 4. MAXIMUM MOLD PROTRUSION 0.150 (0.006) PER SIDE.
 5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	12.65	12.95	0.499	0.510
B	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.50	0.90	0.020	0.035
G	1.27 BSC		0.050 BSC	
J	0.25	0.32	0.010	0.012
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029

Figure 11-3. 20-Pin SOIC Mechanical Dimensions

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